

Intel[®] Server System R1000EP Product Family

Technical Product Specification

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Enterprise Platforms and Services Division



Revision History

Date	Revision Number	Modifications
May 2012	1.0	Initial release.
May 2012	1.01	Update some contents.

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1. Introduction

This Technical Product Specification (TPS) provides system level information for the Intel[®] Server System R1000EP product family. It describes the functions and features of the integrated server system which includes the chassis layout, system boards, power sub-system, cooling sub-system, storage sub-system options, and available installable options. Server board specific detail can be obtained by referencing the *Intel[®] Server Board S2400EP Technical Product Specification*.

In addition, design-level information related to specific server board components/subsystems can be obtained by ordering External Product Specifications (EPS) or External Design Specifications (EDS) related to this server generation. EPS and EDS documents are made available under NDA with Intel[®] and must be ordered through your local Intel[®] representative. See the Reference Documents section at the end of this document for a complete list of available documents.

1.1 Chapter Outline

This document is divided into the following chapters:

- Chapter 1 Introduction
- Chapter 2 Product Family Overview
- Chapter 3 Power Subsystem
- Chapter 4 Thermal Management
- Chapter 5 System Storage and Peripheral Options
- Chapter 6 Storage Controller Options Overview
- Chapter 7 Front Control Panel and I/O Panel Overview
- Chapter 8 Intel[®] Local Control Panel
- Chapter 9 PCI Riser Card Support
- Chapter 10 Mezzanine Module Support
- Appendix A Integration and Usage Tips
- Appendix B POST Code Diagnostic LED Decoder
- Appendix C Post Code Errors
- Glossary
- Reference Documents

1.2 Server Board Use Disclaimer

Intel Corporation server boards support add-in peripherals and contain a number of high-density VLSI and power delivery components that need adequate airflow to cool. Intel[®] ensures through its own chassis development and testing that when Intel[®] server building blocks are used together, the fully integrated system will meet the intended thermal requirements of these components. It is the responsibility of the system integrator who chooses not to use Intel[®]-developed server building blocks to consult vendor datasheets and operating parameters to determine the amount of airflow required for their specific application and environmental conditions. Intel Corporation cannot be held responsible if components fail or the server board does not operate correctly when used outside any of their published operating or non-operating limits.

1.3 Product Errata

The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Product Errata are documented in the *Intel[®]* Server Board S2400EP, *Intel[®]* Server System R1000EP Monthly Specification Update which can be downloaded from http://www.intel.com/support.

2. Product Family Overview

This generation of Intel[®] 1U server platforms offers a variety of system options to meet the varied configuration requirements of high-density high-performance computing environments. The Intel[®] Server System R1000EP product family is comprised of several available 1U rack mount server systems that are all integrated with an Intel[®] Server Board S2400EP.

This chapter provides a high-level overview of the system features and available options as supported in different platform SKUs within this server family. Greater detail for each major system component or feature is provided in the following chapters.

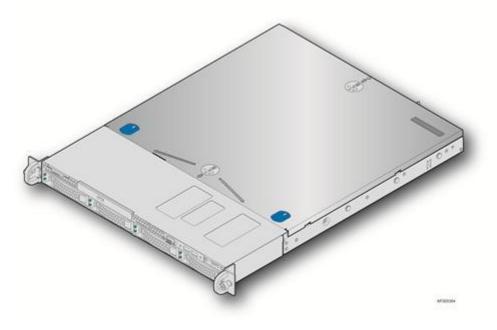
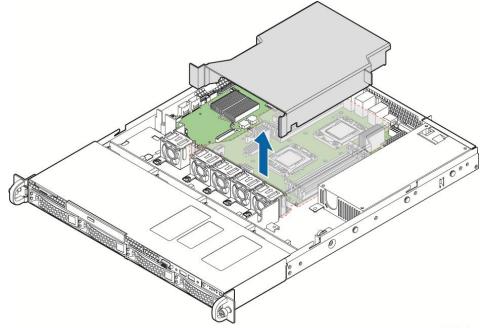


Figure 1. Intel[®] Server System R1000EP



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Figure 2. Intel[®] Server System R1000EP without Top Cover

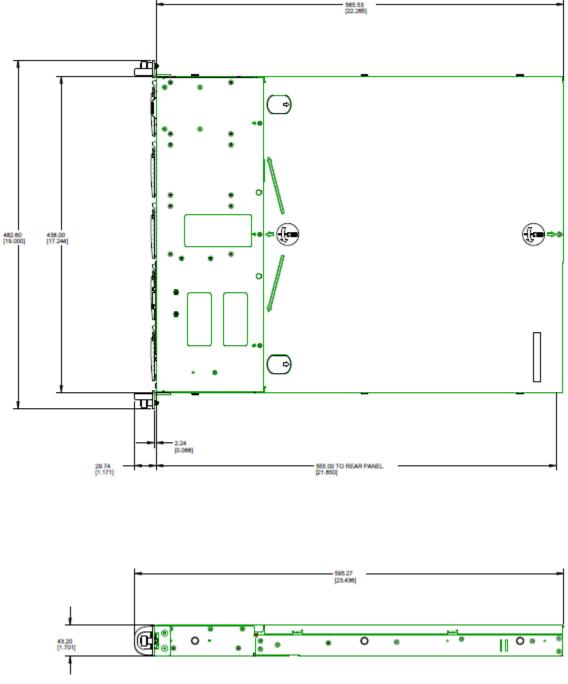
Table	1.	System	Feature Set
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Server System	Integrated Server Board
Intel [®] Server System R1000EP product family	Intel [®] Server Board S2400EP

Feature	Description
Processor Support	 Support for one or two Intel[®] Xeon[®] processors E5-2400 product family with a Thermal Design Power (TDP) of up to 95 Watts.
	 Eight DIMM slots – one DIMM/Channel on Channel A,B,D and E; two DIMMs/Channel on Channel C and F – three memory channels per processor
	 Unbuffered DDR3 (UDIMM) and registered DDR3 (RDIMM)
Memory	 Memory DDR3 data transfer rates of 800, 1066, 1333, and 1600 MT/s
	 DDR3 standard I/O voltage of 1.5V and DDR3 Low Voltage of 1.35V
Chipset	Intel [®] C602 chipset with support for optional Intel [®] RAID C600 Upgrade keys
	 Video (back and front video connectors)
	 RJ-45 Serial- A Port
External I/O	 Two RJ-45 Network Interface Connectors supporting 10/100/1000Mb for system with S2400EP2
connections	 Four RJ-45 Network Interface Connectors supporting 10/100/1000Mb for system with S2400EP2
	 USB 2.0 connectors - 4 on back panel + 2 on front panel
Internal I/O connectors/headers	One Type-A USB 2.0 connector

I/O Module Accessory Options	 The following I/O modules utilize a single proprietary on-board connector. An installed I/O module can be supported in addition to standard on-board features and any add-in expansion cards. Quad port 1 GbE based on Intel[®] Ethernet Controller I350 – RMS25CB0080 Dual port 10GBase-T Ethernet module based on Intel[®] Ethernet Controller I350 – AXX10GBTWLIOM Dual SFP+ port 10GbE module based on Intel[®] 82500 10 GbE controller – AXX10GBNIAIOM Single Port FDR speed InfiniBand module with QSFP connector – AXX1FDRIBIOM Intel[®] Quick Assist Accelerator Card – AXXQAAIOMOD Intel[®] SAS Roc Module
System Fans	 Five single rotor managed system fans
Riser Cards	Support for one PCIe riser card. Slot #6 (PCIe x16): Single add-in card slot – PCIe x16 lanes, x16 slot (ships with system)
Video	Integrated 2D Video Controller16 MB DDR3 Memory
On-board storage controllers and options	 Two 7-pin single port AHCI SATA connectors capable of supporting up to 6 Gb/sec Two SCU 4-port mini-SAS connectors capable of supporting up to 3 Gb/sec SAS/SATA SCU 0 Port (Enabled standard) SCU 1 Port (Requires Intel[®] RAID C600 Upgrade Key) Intel[®] RAID C600 Upgrade Key support providing optional expanded SATA/SAS RAID capabilities
Security	Intel [®] Trusted Platform Module (TPM) - AXXTPME5 (Accessory Option)
Server Management	 Integrated Baseboard Management Controller, IPMI 2.0 compliant Support for Intel[®] Server Management Software Intel[®] Remote Management Module 4 Lite – Accessory option Intel[®] Remote Management Module 4 Management NIC – Accessory option
Power Supply Options	AC 80 PLUS compliant 600W
Storage Bay Options	 4x – 3.5" SATA/SAS Fixed Hard Drive Bays + Optical Drive support 4x – 3.5" SATA/SAS Fixed Hot Swap Hard Drive Bays + Optical Drive support 8x – 2.5" SATA/SAS Hot Swap Hard Drive Bays
Supported Rack Mount Kit Accessory Options	 Tool-less rack mount rail kit – Intel Product Code – AXXPRAIL Value rack mount rail kit – Intel Product Code – AXXVRAIL Cable Management Arm – Intel Product Code – AXX1U2UCMA (*supported with AXXPRAIL only) 2-post fixed mount bracket kit – Intel Product Code – AXX2POSTBRCKT

2.1 Chassis Dimensions





2.2 System Level Environmental Limits

The following table defines the system level operating and non-operating environmental limits.

Parameter		Limits
Temperature		
	Operating	ASHRAE Class A2 – Continuous Operation. 10° C to 35° C (50° F to 95° F) with the maximum rate of change not to exceed 10°C per hour
		ASHRAE Class A3 – Includes operation up to 40C for up to 900 hrs per year.
		ASHRAE Class A4 – Includes operation up to 45C for up to 90 hrs per year.
	Shipping	-40° C to 70° C (-40° F to 158° F)
Altitude		
	Operating	Support operation up to 3050m with ASHRAE class deratings.
Humidity		
	Shipping	50% to 90%, non-condensing with a maximum wet bulb of 28° C (at temperatures from 25° C to 35° C)
Shock		
	Operating	Half sine, 2g, 11 mSec
	Unpackaged	Trapezoidal, 25 g, velocity change is based on packaged weight
	Packaged	Product Weight: ≥ 40 to < 80 Non-palletized Free Fall Height = 18 inches Palletized (single product) Free Fall Height = NA
Vibration		
	Unpackaged	5 Hz to 500 Hz 2.20 g RMS random
	Packaged	5 Hz to 500 Hz 1.09 g RMS random
AC-DC		
	Voltage	90 Hz to 132 V and 180 V to 264 V
	Frequency	47 Hz to 63 Hz
	Source Interrupt	No loss of data for power line drop-out of 12 mSec
	Surge Non- operating and operating	Unidirectional
	Line to earth	AC Leads 2.0 kV
	Only	I/O Leads 1.0 kV
500		DC Leads 0.5 kV
ESD	Air Diaut	
	Air Discharged	12.0 kV
	Contact Discharge	8.0 kV
Acoustics Sound Power Measured		
	Power in Watts	<300 W ≥300 W ≥600 W ≥1000 W
	Servers/Rack Mount BA	7.0 7.0 7.0 7.0

Table 2. System Environmental Limits Summary

See the Intel[®] S2400EP Product Family Power Budget and Thermal Configuration Tool for system configuration requirements and limitations.

2.3 System Features and Options Overview

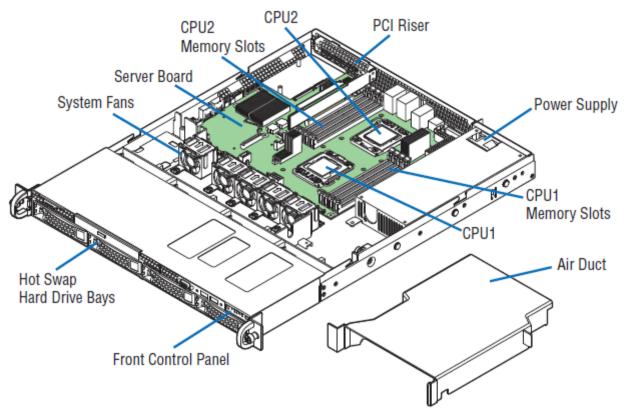


Figure 4. System Components Overview

2.3.1 Hot Swap Hard Drive Bay and Front Panel Options

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Figure 5. 3.5" Hard Drive Bay - 4 Drive Configuration

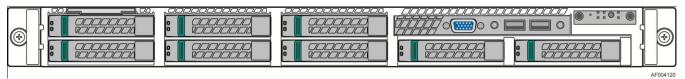


Figure 6. 2.5" Hard Drive Bay - 8 Drive Configuration

2.3.2 Back Panel Features

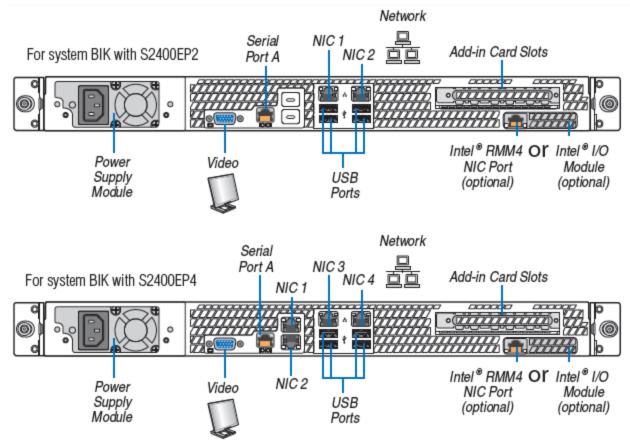
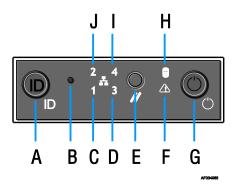


Figure 7. Back Panel Feature Identification

2.3.3 Front Control Panel Options



А	System ID Button w/Integrated LED	F	System Status LED
В	B NMI Button (recessed, tool required for use)		Power Button w/Integrated LED
С	NIC-1 Activity LED	Н	Hard Drive Activity LED
D	NIC-3 Activity LED	Ι	NIC-4 Activity LED
Е	System Cold Reset Button	J	NIC-2 Activity LED

Figure 8. Front Control Panel Options

2.4 Server Board Features Overview

The following illustration provides a general overview of the server board, identifying key feature and component locations.

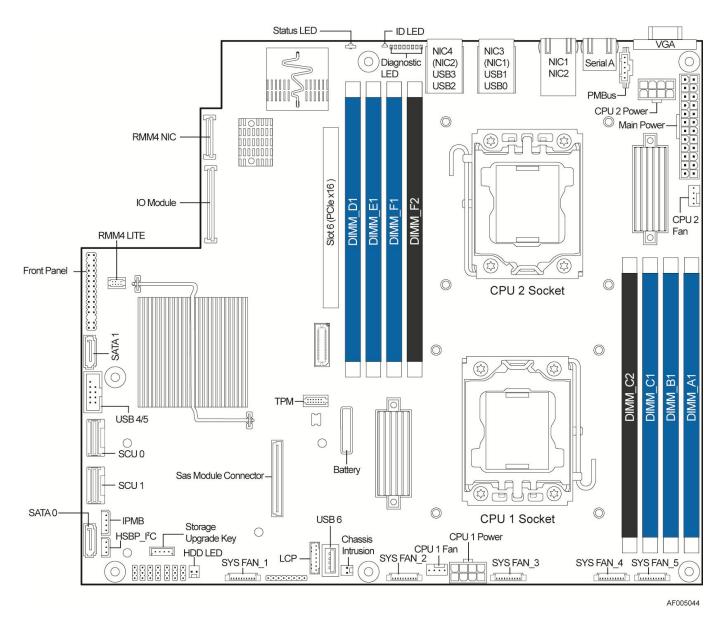


Figure 9. Intel[®] Server Board S2400EP

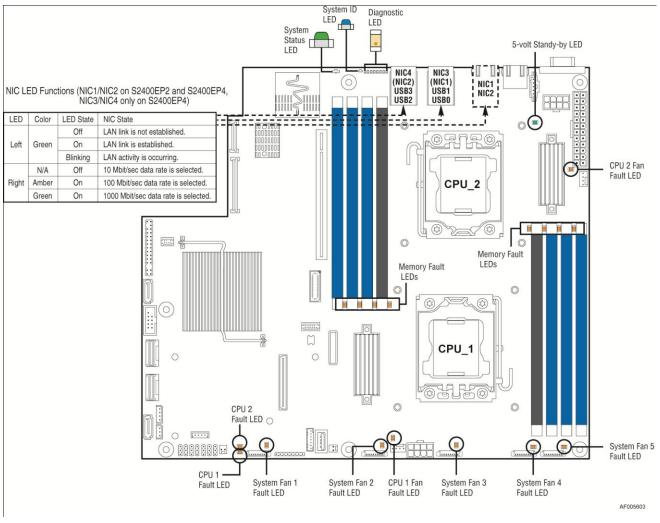


Figure 10. Intel[®] Light-Guided Diagnostic LEDs - Server Board

2.5 Available Front Bezel Support

The optional front bezel is made of molded plastic and uses a snap-on design. When installed, its design allows for maximum airflow to maintain system cooling requirements. The face of the bezel assembly includes optional snap-in identification badge and wave (shown) features to allow for customization.

(Intel Product Order Code – A1UBEZEL)

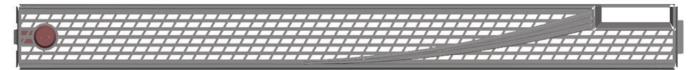


Figure 11. The Optional Front Bezel

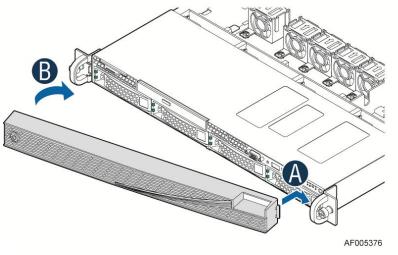


Figure 12. Installing the Optional Front Bezel

2.6 Available Rack and Cabinet Mounting Kit Options

- Tool-less rack mount rail kit Intel Product Code AXXPRAIL
 - 1U and 2U compatible
 - 65 lbs max support weight
 - Tool-less installation
 - Full extension from rack
 - Drop in system install
 - Optional cable management arm support
- Value rack mount rail kit Intel Product Code AXXVRAIL
 - 1U to 4U compatible
 - 130 lbs max support weight
 - Tool-less chassis attach
 - Tools required to attach to rails to rack
 - 2/3 extension from rack
- Cable Management Arm Intel Product Code AXX1U2UCMA (*supported with AXXPRAIL only)
- 2-Post Fixed mount bracket kit Intel Product Code AXX2POSTBRCKT.

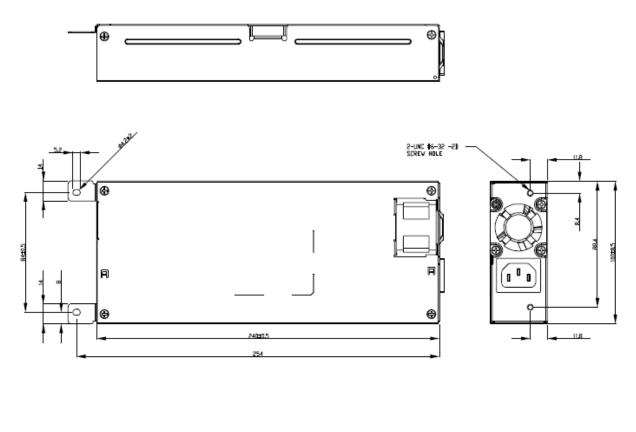
3. Power Subsystem

This chapter will provide a high level overview of the power management features and specification data for the power supply options available for this server product.

The server system support one fixed power supply. The power supply option available for this server product: 600W AC. This is a single-phase full range AC input, active power factor correction switching power supply with 600 Watts output including +12V1, +12V2, +12V3, +5V, +3.3V, -12V and +5VSB.

3.1 Mechanical Overview

The physical size of the power supply enclosure is 39/40mm x 74mm x 185mm. The power supply contains a single 40mm fan. The power supply has a card edge output that interfaces with a 2x25 card edge connector in the system.



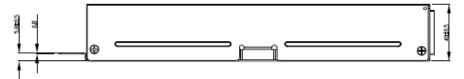


Figure 13. Power Supply Module Mechanical Drawing

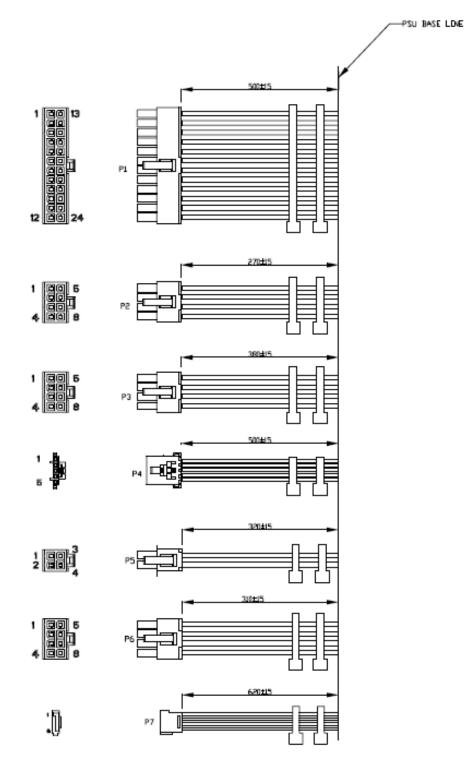


Figure 14. Power Supply Cable Harness

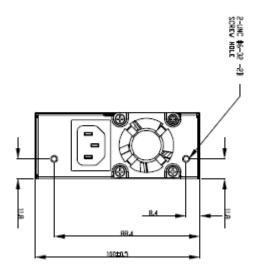


Figure 15. AC and DC Power Supplies - Connector View

3.2 Main Power Layout

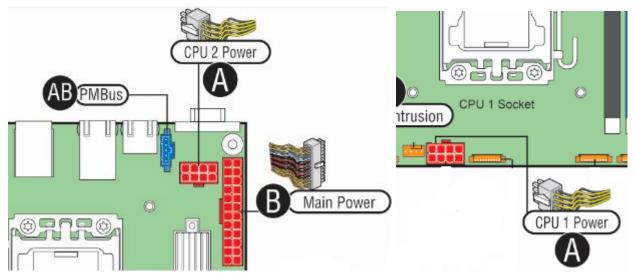


Figure 16. Main Power Connector Identification

3.3 Power Connectors

3.3.1 Power Supply Module Card Edge Connector

Each power supply module has a single 2x25 card edge output connection that plugs directly into a matching slot connector on the server board (PSU#1) and power distribution board (PSU#2). The connector provides both power and communication signals. The following table defines the connector pin-out.

Pin	Name	Pin	Name
A1	GND	B1	GND

Pin	Name	Pin	Name
A2	GND	B2	GND
A3	GND	B3	GND
A4	GND	B4	GND
A5	GND	B5	GND
A6	GND	B6	GND
A7	GND	B7	GND
A8	GND	B8	GND
A9	GND	B9	GND
A10	+12V	B10	+12V
A11	+12V	B11	+12V
A12	+12V	B12	+12V
A13	+12V	B13	+12V
A14	+12V	B14	+12V
A15	+12V	B15	+12V
A16	+12V	B16	+12V
A17	+12V	B17	+12V
A18	+12V	B18	+12V
A19	PMBus SDA	B19	A0 (SMBus address)
A20	PMBus SCL	B20	A1 (SMBus address)
A21	PSON	B21	12V stby
A22	SMBAlert#	B22	Cold Redundancy Bus
A23	Return Sense	B23	12V load share bus
A24	+12V remote Sense	B24	No Connect
A25	PWOK	B25	Compatibility Check pin*

The server board provides several connectors to provide power to various system options. The following sub-sections will identify the location; provide the pin-out definition; and provide a brief usage description for each.

3.3.2 Hot Swap Backplane Power Connector

The server board includes one white 2x4-pin power connector that is cabled to the hot swap backplane. On the server board, this connector is labeled as "HSBP PWR". The following table provides the pin-out for this connector.

Signal Description	Pin#	Pin#	Signal Description
P12V_240VA	5	1	GROUND
P12V_240VA	6	2	GROUND
P12V_240VA	7	3	GROUND
P12V_240VA	8	4	GROUND

3.3.3 Optical Drive Power Connector

The server board includes one brown 2x3-pin power connector intended to provide power to an optionally installed optical drive. On the server board this connector is labeled as "ODD/SSD PWR". The following table provides the pin-out for this connector.

Signal Description	Pin#	Pin#	Signal Description
P12V	4	1	P5V
P3V3	5	2	P5V
GROUND	6	3	GROUND

 Table 5. Peripheral Drive Power Connector Pin-out ("ODD/SSD PWR")

3.4 **Power Supply Module Efficiency**

The following table provides the required minimum efficiency level at various loading conditions. These are provided at three different load levels: 100%, 50% and 20%. Efficiency is tested over an AC input voltage range of 115 VAC to 220 VAC.

Table 6. 600 Watt AC Power Supply Efficiency

Loading	100% of maximum	50% of maximum	20% of maximum
Minimum Efficiency	>=85%	>=88%	>=85%

3.5 **Power Cord Specification Requirements**

Power cords used must meet the specification requirements listed in the following table.

Table 7. AC Power Cord Specifications

Cable Type	SJT
Wire Size	16 AWG
Temperature Rating	105ºC
Amperage Rating	13 A
Voltage Rating	125 V

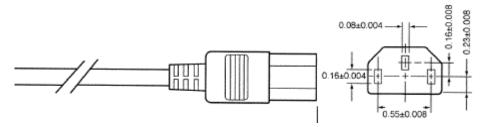


Figure 17. AC Power Cord

3.6 AC Input Requirement

3.6.1 Power Factor

The power supply must meet the power factor requirements stated in the Energy Star[®] Program Requirements for Computer Servers. These requirements are stated below. For all loading conditions where the output power is greater than or equal to 75 watts.

Output power	20% load	50% load	100% load
Power factor	0.80	0.90	0.98

Tested at 230Vac, 50Hz and 60Hz and 115VAC, 60Hz

3.6.2 AC Input Voltage Specification

Frequency

The power module shall operate over the range and limits shown in the following table:

47 Hz

PARAMETER	MIN	RATED	VMAX
Voltage (110)	90 Vrms	100-127 Vrms	140 Vrms
Voltage (220)	180 Vrms	200-240 Vrms	264 Vrms

Table 8. AC Input Voltage Range

Notes:

1. Maximum input current at low input voltage range shall be measured at 90VAC, at max load.

50/60

63 Hz

2. Maximum input current at high input voltage range shall be measured at 180VAC, at max load.

3.6.3 AC Line Dropout/Holdup

An AC line dropout is defined when the AC input drops to 0VAC at any phase angle of the nominal AC line voltage. An AC line dropout less than 10ms shall not cause any tripping of control signals or protection circuits for 600W output. If the AC line dropout over 10ms, the power supply should recover back to normal operation and meet all turn on requirements. Any dropout of the AC line shall not cause damage to the power supply.

3.6.4 AC Line Transient Specification

AC line transient conditions shall be defined as "sag" and "surge" conditions. "Sag" conditions are also commonly referred to as "brownout", these conditions will be defined as the AC line voltage dropping below nominal voltage conditions. "Surge" will be defined to refer to conditions when the AC line voltage rises above nominal voltage. The power supply shall meet the requirements under the following AC line sag and surge conditions.

AC Line Sag (10sec interval between each sagging)				
Duration	Sag	Operating AC Voltage	Line Frequency	Performance Criteria
Continuous	10%	Nominal AC Voltage ranges	50/60Hz	No loss of function or performance
1 to 12ms	100%	Nominal AC Voltage ranges	50/60Hz	No loss of function or performance
> 12ms	>30%	Nominal AC Voltage ranges	50/60Hz	Loss of function acceptable, self recoverable

Table 9. AC Line Sag Transient Performance

Table 10. AC Line Surge Transient Performance

AC Line Sag (10sec interval between each sagging)				
Duration	Sag	Operating AC Voltage	Line Frequency	Performance Criteria
Continuous	10%	Nominal AC Voltage ranges	50/60Hz	No loss of function or performance
1 to 12ms	100%	Nominal AC Voltage ranges	50/60Hz	No loss of function or performance
> 12ms	>30%	Nominal AC Voltage ranges	50/60Hz	Loss of function acceptable, self recoverable

3.6.5 AC Line Surge Immunity

The power supply shall be tested with the system for immunity to AC Ring Wave and AC Unidirectional wave, both up to 2kV. Power supply shall operate normally without any component damage under any condition.

BI-WAVE 12Ω±2.0kV (Common mode) 2Ω±1.0kV (Differential mode) RING-WAVE 500A±2.0kV (Common mode) 500A±1.0kV (Differential mode)

3.6.6 AC Inrush

The peak inrush current shall be less than 55A peak at 115VAC input and 230VAC input, Cold start and 25degree C.

3.6.7 Susceptibility Requirements

The power supply shall meet the following electrical immunity requirements when connected to a cage with an external EMI filter which meets the criteria defined in the SSI document EPS Power Supply Specification. For further information on Intel[®] standards please request a copy of the Intel[®] Environmental Standards Handbook

Table 11. Performance Criteria

Level	Description
А	The apparatus shall continue to operate as intended. No degradation of performance.
В	The apparatus shall continue to operate as intended. No degradation of performance beyond spec limits.
С	Temporary loss of function is allowed provided the function is self-recoverable or can be restored by the operation of the controls.

3.6.8 Electrostatic Discharge Susceptibility

The power supply shall comply with the limits defined in EN 55024: 1998 using the IEC 61000-4-2:1995 test standard and performance criteria B defined in Annex B of CISPR 24.

AIR DISCHARGE ±8kV CONTACT DISCHARGE ±4kV

3.6.9 Protection Circuits

If the power supply latches off due to a protection circuit tripping, an AC cycle OFF for 15sec min (with +5VSB/0.1A) and a PSON[#] cycle HIGH for 1sec shall be able to reset the power supply.

3.6.10 Over-current Protection (OCP)

Each output shall have individual OCP protection circuits. The PSU shall shutdown and latch off after an over current condition occurs. Whereas OCP of +5VSB shall turn the power supply into "hiccup mode" until the OCP condition removed. The values are measured at the PSU harness connectors and shall not be damaged from repeated power cycling in this condition. There shall be current sensors and limit circuits to shut down the entire power supply if the limit is exceeded. The limits are listed below.

	Continuous Load		
Output Voltage	Current Limit MIN	Current Limit MAX	
+12V1	36A	41A	
+12V2	18.2A	20A	
+12V3	18.2A	20A	
+5V	5.5A	10A	
+3.3V	15.5A	20A	

Table 12. 600 Watt Power Supply Over Load Limits

-12V	4A
+5VSB	4.5A

3.6.11 Over-voltage Protection (OVP)

Each output shall have individual OVP protection circuits built in and it shall be locally sensed. The PSU shall shutdown and latch off after an over voltage condition occurs. The output voltages are measured at the harness connectors. The voltage shall never exceed the maximum levels when measured at the power pins of the output harness connector during any single point of fail. The voltage shall never trip any lower than the minimum levels when measured at the power pins of the connector.

Output Voltage	OVP MIN (V)	OVP MAX (V)
+3.3V	3.7	4.5
+5V	5.7	6.5
+12V1/+12V2/+12V3	13.3	15.6
-12V	-13.3	-15.6
+5VSB	5.7	6.5

Table 13. Over Voltage Protection (OVP) Limits

3.6.12 Over-temperature Protection (OTP)

The power supply shall be protected against over temperature conditions caused by loss of fan cooling or excessive ambient temperature. In an OTP condition the PSU will shut down. When the power supply temperature drops to within specified limits, the power supply shall restore power automatically, while the +5VSB remains always on. The OTP trip level shall have a minimum of 4°C of ambient temperature hysteresis, so that the power supply will not oscillate on and off due to temperature recovery condition.

4. Thermal Management

The fully integrated system is designed to operate at external ambient temperatures of between 10°C- 35°C with limited excursion based operation up to 45°C, as specified in Table 2. Working with integrated platform management, several features within the system are designed to move air in a front to back direction, through the system and over critical components in order to prevent them from overheating and allow the system to operate with best performance.

The Intel[®] Server System R1000EP product family supports short-term, excursion-based, operation up to 45°C (ASHRAE A4) with limited performance impact. The configuration requirements and limitations are described in the configuration matrix found in the *Intel[®] S2400EP Product Family Power Budget and Thermal Configuration Tool,* available as a download online at <u>http://www.intel.com/support</u>.

The installation and functionality of several system components are used to maintain system thermals. They include five managed single rotor 40mm x 28mm system fans, an air duct, populated hard drive carriers, and installed CPU heats sinks. Hard drive carriers can be populated with a hard drive or supplied drive blank. In addition, it may be necessary to have specific DIMM slots populated with DIMMs or supplied DIMM blanks.

4.1 Thermal Operation and Configuration Requirements

To keep the system operating within supported maximum thermal limits, the system must meet the following operating and configuration guidelines:

- The system operating ambient is designed for sustained operation up to 35°C (ASHRAE Class A2) with short term excursion based operation up to 45°C (ASHRAE Class A4).
 - The system can operate up to 40°C (ASHRAE Class A3) for up to 900 hours per year
 - The system can operate up to 45°C (ASHRAE Class A4) for up to 90 hours per year
 - When operating within the extended operating temperature range, then system performance may be impacted.
 - There is no long term system reliability impact when operating at the extended temperature range within the approved limits.
- Specific configuration requirements and limitations are documented in the configuration matrix found in the Intel[®] Server Board S2400EP product family Power Budget and Thermal Configuration Guidelines Tool, available as a download online at <u>http://www.intel.com</u>.
- The CPU-1 processor + CPU heat sink must be installed first. The CPU-2 heat sink must be installed at all times, with or without a processor installed.
- Memory Slot population requirements
 - **DIMM Population Rules on CPU-1** Install DIMMs in order; Channels A, B, and C, Start with1st DIMM (Blue Slot) on each channel, then slot 2.
 - DIMM Population Rules on CPU-2 Install DIMMs in order; Channels D, E, and F. Start with1st DIMM (Blue Slot) on each channel, then slot 2.
- All hard drive bays must be populated. Hard drive carriers can be populated with a hard drive or supplied drive blank.
- The air duct must be installed at all times.

• The system top-cover must be installed at all times.

4.2 Thermal Management Overview

In order to maintain the necessary airflow within the system, all of the previously listed components and top cover need to be properly installed. For best system performance, the external ambient temperature should remain below 35°C and all system fans should be operational.

Note: All system fans are controlled independent of each other. The fan control system may adjust fan speeds for different fans based on increasing/decreasing temperatures in different thermal zones within the chassis.

In the event that system thermals should continue to increase with the system fans operating at their maximum speed, platform management may begin to throttle bandwidth of either the memory subsystem or the processors or both, in order to keep components from overheating and keep the system operational. Throttling of these sub-systems will continue until system thermals are reduced below preprogrammed limits.

Should system temperatures increase to a point beyond the maximum thermal limits, the system will shut down, the System Status LED will change to a solid Amber state, and the event will be logged to the system event log.

Note: Sensor data records (SDRs) for any given system configuration must be loaded by the system integrator for proper thermal management of the system. SDRs are loaded using the FRUSDR utility.

An intelligent Fan Speed Control (FSC) and thermal management technology (mechanism) is used to maintain comprehensive thermal protection, deliver the best system acoustics, and fan power efficiency. Options in <F2> BIOS Setup (**BIOS>Advanced>System Acoustic and Performance Configuration)** allow for parameter adjustments based on the actual system configuration and usage. Refer to the following sections for a description of each setting.

4.2.1 Set Throttling Mode

This option is used to select the desired memory thermal throttling mechanism. Available settings include:

[Auto], [DCLTT], [SCLTT] and [SOLTT].

[Auto] – Factory Default Setting - BIOS automatically detects and identifies the appropriate thermal throttling mechanism based on DIMM type, airflow input, and DIMM sensor availability.

[DCLTT] – Dynamic Closed Loop Thermal Throttling: for the SOD DIMM with system airflow input

[SCLTT] – Static Close Loop Thermal Throttling: for the SOD DIMM without system airflow input

[SOLTT] – Static Open Loop Thermal Throttling: for the DIMMs without sensor on DIMM (SOD)

4.2.2 Altitude

This option is used to select the proper altitude that the system will be used in. Available settings include: [300m or less], **[301m-900m]**, [901m-1500m], [Above 1500m].

Selecting an altitude range that is lower than the actual altitude the system will be operating at, can cause the fan control system to operate less efficiently, leading to higher system thermals and lower system performance. If the altitude range selected is higher than the actual altitude the system will be operating at, the fan control system may provide better cooling but with higher acoustics and higher fan power consumption. If the altitude is not known, selecting a higher altitude is recommended in order to provide sufficient cooling

4.2.3 Set Fan Profile

This option is used to set the desired Fan Profile. Available settings include:

[Performance] and [Acoustic].

The Acoustic mode offers best acoustic experience and appropriate cooling capability covering mainstream and majority of the add-in cards with 100LFM thermal requirements. Performance mode is designed to provide sufficient cooling capability covering all kinds of add-in cards on the market. For any add-in card requiring more than 100LFM, performance mode must be selected to provide sufficient cooling capability.

4.2.4 Fan PWM Offset

This option is reserved for manual adjustment to the minimum fan speed curves. The valid range is from [0 to 100] which stands for 0% to 100% PWM adding to the minimum fan speed. This feature is valid when Quiet Fan Idle Mode is at Enabled state. The default setting is [0]

4.2.5 Quiet Fan Idle Mode

This feature can be [Enabled] or [Disabled]. If enabled, the fans will either shift to a lower speed or stop when the aggregate sensor temperatures are satisfied, indicating the system is at ideal thermal/light loading conditions. When the aggregate sensor temperatures are not satisfied, the fans will shift back to normal control curves. If disabled, the fans will never shift into lower fan speeds or stop, regardless of whether the aggregate sensor temperatures are satisfied or not. The default setting is [Disabled]

Note: The above feature may or may not be in effect and depends on the actual thermal characteristics of the specified system.

4.2.6 Thermal Sensor Input for Fan Speed Control

The BMC uses various IPMI sensors as inputs to fan speed control. Some of the sensors are actual physical sensors and some are "virtual" sensors derived from calculations.

The following IPMI thermal sensors are used as input to fan speed control:

- Front Panel Temperature Sensor¹
- CPU Margin Sensors^{2,4,5}
- DIMM Thermal Margin Sensors^{2,4}
- Exit Air Temperature Sensor^{1,7,9}
- PCH Temperature Sensor^{3,5}
- On-board Ethernet Controller Temperature Sensors^{3, 5}
- Add-In Intel[®] SAS/IO Module Temperature Sensors^{3, 5}
- PSU Thermal Sensor^{3, 8}
- CPU VR Temperature Sensors^{3, 6}

- DIMM VR Temperature Sensors^{3, 6}
- BMC Temperature Sensor^{3, 6}
- Global Aggregate Thermal Margin Sensors⁷
- Hot Swap Backplane Temperature Sensors
- I/O module Temperature Sensor (With option installed)
- Intel[®] ROC Module (With option installed)

Notes:

- 1. For fan speed control in Intel[®] chassis
- 2. Temperature margin from throttling threshold
- 3. Absolute temperature
- 4. PECI value or margin value
- 5. On-die sensor
- 6. On-board sensor
- 7. Virtual sensor
- 8. Available only when PSU has PMBus*
- 9. Calculated estimate

The following diagram illustrates the fan speed control structure

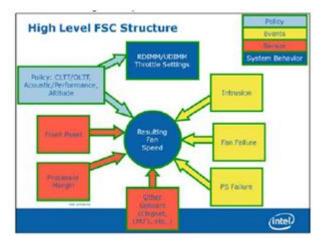


Figure 18. Fan Control Model

4.3 System Fans

Five managed single rotor 40mm x 28mm system fans and an embedded fan for installed power supply, provide the primary airflow for the system. The system is designed for fixed fans when configured with one fixed power supply module.

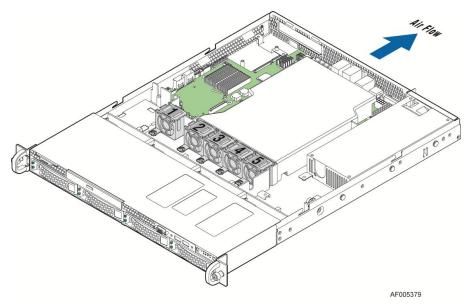


Figure 19. System Fan Identification

Each system fan is mounted inside its own plastic fan housing which include rotational vibration dampening features. The fan assemblies are held in place by fitting them over mounting pins coming up from the chassis base.

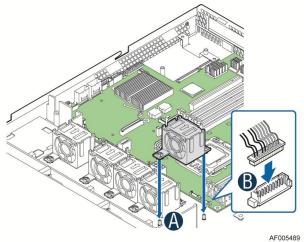


Figure 20. System Fan Assembly

The system fan assembly is designed for ease of use and supports several features.

System fans are NOT hot-swappable.

Each fan and fan assembly is designed for tool-less insertion and extraction from the system. For instructions on fan replacement, see the $Intel^{\mathbb{B}}$ Server System R1000EP Service Guide.

Fan speed for each fan is controlled by integrated platform management as controlled by the integrated BMC on the server board. As system thermals fluctuate high and low, the integrated BMC firmware will increase and decrease the speeds to specific fans to regulate system thermals.

Each fan has a tachometer signal that allows the integrated BMC to monitor its status.

Each fan has a10-pin wire harness that connects to a matching connector on the server board.

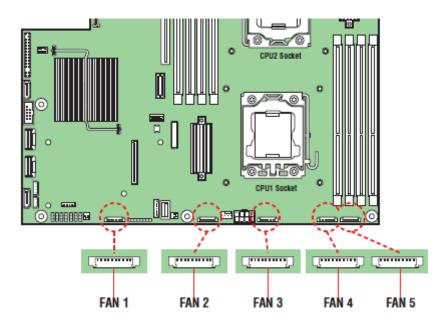


Figure 21. Intel[®] Server System R1000EPServer Board System Fan Connector Locations

SYS_FAN 1		SYS_FAN 2		SYS_FAN 3	
Signal Description	Pin#	Signal Description	Pin#	Signal Description	Pin#
FAN_TACH1_IN	1	FAN_TACH3_IN	1	FAN_TACH5_IN	1
FAN_IBMC_PWM0_R_BUF	2	FAN_IBMC_PWM1_R_BUF	2	FAN_IBMC_PWM2_R_BUF	2
P12V_FAN	3	P12V_FAN	3	P12V_FAN	3
P12V_FAN	4	P12V_FAN	4	P12V_FAN	4
FAN_TACH0_IN	5	FAN_TACH2_IN	5	FAN_TACH4_IN	5
GROUND	6	GROUND	6	GROUND	6
GROUND	7	GROUND	7	GROUND	7
FAN_SYS0_PRSNT_N	8	FAN_SYS1_PRSNT_N	8	FAN_SYS2_PRSNT_N	8
LED_FAN_FAULT0_R	9	LED_FAN_FAULT1_R	9	LED_FAN_FAULT2_R	9
LED_FAN0	10	LED_FAN1	10	LED_FAN2	10
SYS_FAN 4		SYS_FAN 5			
Signal Description	Pin#	Signal Description	Pin#		
FAN_TACH7_IN	1	FAN_TACH9_IN	1		
FAN_IBMC_PWM3_R_BUF	2	FAN_IBMC_PWM4_R_BUF	2		
P12V_FAN	3	P12V_FAN	3		
P12V_FAN	4	P12V_FAN	4		
FAN_TACH6_IN	5	FAN_TACH8_IN	5		
GROUND	6	GROUND	6		
GROUND	7	GROUND	7		
FAN_SYS3_PRSNT_N	8	FAN_SYS4_PRSNT_N	8		
LED_FAN_FAULT3_R	9	LED_FAN_FAULT4_R	9		
LED_FAN3	10	LED_FAN4	10		

Table 14. System Fan Connector Pin-out

4.4 **Power Supply Fans**

The installed power supply module includes one embedded (non-removable) fan. It is responsible for airflow through the power supply module. Should this fan fail, the power supply

will continue to operate until its internal temperature reaches an upper critical limit. The power supply will be protected against over temperature conditions caused by loss of fan cooling or excessive ambient temperature. In an over-temperature protection condition, the power supply module will shut down.

4.5 FRUSDR Utility

The purpose of the embedded platform management and fan control systems is to monitor and control various system features, and to maintain an efficient operating environment. Platform management is also used to communicate system health to supported platform management software and support mechanisms. The FRUSDR utility is used to program the server board with platform specific environmental limits, configuration data, and the appropriate sensor data records (SDRs), for use by these management features.

The FRUSDR utility must be run as part of the initial platform integration process before it is deployed into a live operating environment. It must be run with the system fully configured and each time the system configuration changes.

The FRUSDR utility for the given server platform can be run as part of the *Intel[®]* Server Deployment Toolkit and Management DVD that ships with each Intel server, or can be downloaded from <u>http://www.intel.com/support</u>.

Note: The embedded platform management system may not operate as expected if the platform is not updated with accurate system configuration data. The FRUSDR utility must be run with the system fully configured and each time the system configuration changes for accurate system monitoring and event reporting.

5. System Storage and Peripheral Options

The Intel[®] Server System R1000EP product family has support for many storage device options, including:

- Hot Swap 2.5" Hard Disk Drives
- Hot Swap 3.5" Hard Disk Drives
- Fixed 3.5" Hard Disk Drives
- SATA Optical Drive

Support for different storage and peripheral device options will vary depending on the system SKU. This section will provide an overview of each available option.

5.1 2.5" Hard Disk Drive Support

The server is available with support for eight 2.5" hard disk drives as illustrated below:

		AF004126

Figure 22. 2.5" Hard Drive Bay Drive Configuration

The drive bay can support either SATA or SAS hard disk drives. Mixing of drive types within the hard drive bay is not supported. Hard disk drive type is dependent on the type of host bus controller used, SATA only or SAS. Each 2.5" hard disk drive is mounted to a drive carrier, allowing for hot swap extraction and insertion. Drive carriers have a latching mechanism that is used to extract and insert drives from the chassis, and lock the tray in place.

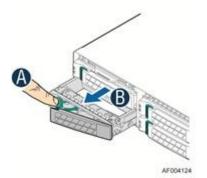


Figure 23. Removing 2.5" Hard Disk Drive

Light pipes integrated into the drive tray assembly direct light emitted from Amber drive status and Green activity LEDs located next to each drive connector on the backplane, to the drive tray faceplate, making them visible from the front of the system.



Figure 24. Drive Status LED States

	Off	No access and no fault
Amber Solid On Hard Drive Fault has occurred		Hard Drive Fault has occurred
	Blink	RAID rebuild in progress (1 Hz), Identify (2 Hz)

Table 15. Drive Activity LED Amber State

	Condition	Drive Type	Behavior
	Power on with no drive activity	SAS	LED stays on
	Power on with no drive activity	SATA	LED stays off
	Bower on with drive activity	SAS	LED blinks off when processing a command
Green	Power on with drive activity	SATA	LED blinks on when processing a command
	Deven en en didiù e en un deven	SAS	LED stays off
	Power on and drive spun down	SATA	LED stays off
	Power on and drive spinning up	SAS	LED blinks
	Fower on and drive spinning up	SATA	LED stays off

Table 16. Drive Activity LED Green State

5.1.1 2.5" Drive Hot-Swap Backplane Overview

A backplane is attached to the back of the drive bay assembly.

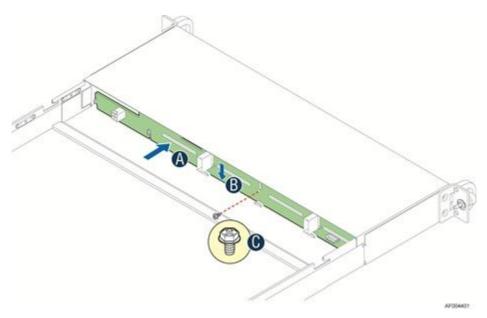


Figure 25. Installing 2.5" Drive Hot-Swap Backplane

Eight hard disk drive interface connectors are mounted on the front side of each backplane (see letter A), each providing both power and I/O signals to the attached hard disk drives.

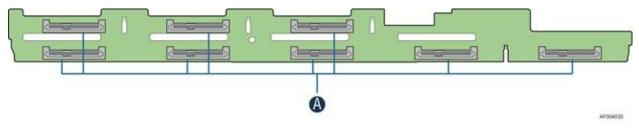


Figure 26. Hard Disk Drive Interface Front Connectors

Several connectors are there on the backside of each backplane. The following illustration identifies each.

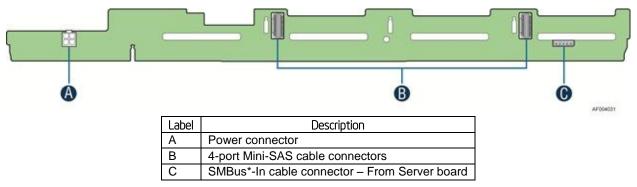


Figure 27. Hard Disk Drive Interface Rear Connectors

A – Power Harness Connector – The backplane includes a 2x2 connector supplying power to the backplane. Power is routed to the backplane through a power cable harness from the server board.

B – Multi-port Mini-SAS Cable Connectors – The backplane includes two multi-port mini-SAS cable connectors, each providing I/O signals for four SAS/SATA hard drives on the backplane. Cables can be routed from matching connectors on the server board, add-in SAS/SATA RAID cards, or optionally installed SAS expander cards.

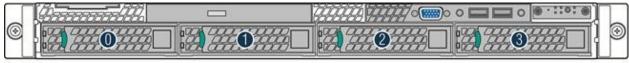
C – SMBus* Cable Connectors – The backplane includes a 1x5 cable connector used as a management interface to the server board.

5.1.2 Cypress* CY8C22545 Enclosure Management Controller

The backplane supports enclosure management using a Cypress* CY8C22545 Programmable System-on-Chip (PSoC*) device. The CY8C22545 drives the hard drive activity/fault LED, hard drive present signal, and controls hard drive power-up during system power-on.

5.2 3.5" Hard Disk Drive Support

The server is available with support for four 3.5" hard disk drives as illustrated below.



AF004129



The drive bay can support either SATA or SAS hard disk drives. Mixing of drive types within the hard drive bay is not supported. Hard disk drive type is dependent on the type of host bus controller used, SATA only or SAS. Each 3.5" hard disk drive is mounted to a drive tray, allowing for hot swap extraction and insertion. Drive trays have a latching mechanism that is used to extract and insert drives from the chassis, and lock the tray in place.

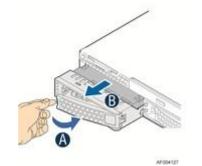


Figure 29. Removing 3.5" Hard Disk Drive

Light pipes integrated into the drive tray assembly direct light emitted from Amber drive status and Green activity LEDs located next to each drive connector on the backplane, to the drive tray faceplate, making them visible from the front of the system.

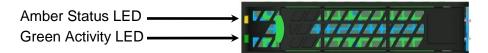


Figure 30. Status and Activity LEDs

	Off	No access and no fault
Amber Solid On Hard Drive Fault has occurred		Hard Drive Fault has occurred
	Blink	RAID rebuild in progress (1 Hz), Identify (2 Hz)

	Condition	Drive Type	Behavior
	Bower on with no drive activity	SAS	LED stays on
	Power on with no drive activity	SATA	LED stays off
	Bower on with drive activity	SAS	LED blinks off when processing a command
Green	Power on with drive activity	SATA	LED blinks on when processing a command
	Power on and drive spun down	SAS	LED stays off
	Fower on and drive spun down	SATA	LED stays off
	Power on and drive spinning up	SAS	LED blinks
	Power on and drive spinning up		LED stays off

5.2.1 3.5" Drive Hot-Swap Backplane Overview

The backplane mounts to the back of the drive bay assembly.

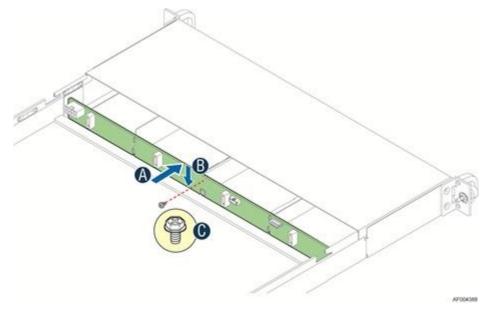


Figure 31. 3.5" Drive Hot-Swap Backplane Installation

Four hard disk drive interface connectors (see letter A) are mounted on the front side of each back plane; each providing both power and I/O signals to the attached hard disk drives.

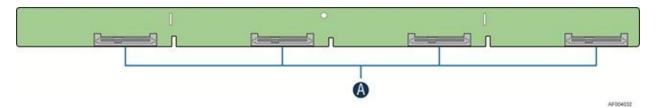


Figure 32. Hard Disk Drive Interface Front Connectors

On the backside of each backplane are several connectors. The following illustration identifies each.

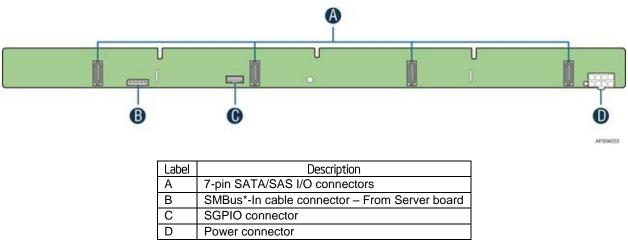


Figure 33. Hard Disk Drive Interface Rear Connectors

A – 7-pin SATA I/O Connectors – The backplane has four 7-pin SATA/SAS I/O connectors, one for each hard drive. A single multi-connector cable is routed from the backplane to a four port

mini-SAS connector on the server board or other optionally installed SATA/SAS host bus adapter.

B – SMBus* Cable Connectors – The backplane includes a 1x5 cable connector used as a management interface to the server board.

C – SGPIO Cable Connector – The SGPIO connector is a management interface used to control the hard drive fault LEDs on the backplane. The SGPIO signals are routed through a multi-connectors cable that is routed to a four port mini-SAS connector on the server board or other optionally installed SATA/SAS host bus adapter.

 \mathbf{D} – Power Harness Connector - The backplane includes a 2x2 connector supplying power to the backplane. Power is routed to the backplane through a power cable harness from the server board.

5.2.2 Cypress* CY8C22545 Enclosure Management Controller

The backplanes support enclosure management using a Cypress* CY8C22545 Programmable System-on-Chip (PSoC*) device. The CY8C22545 drives the hard drive activity/fault LED, hard drive present signal, and controls hard drive power-up during system power-on.

5.3 Fixed 3.5" Hard Disk Support

The drive bay can support either SATA or SAS hard disk drives. Mixing of drive types within the hard drive bay is not supported. Hard disk drive type is dependent on the type of host bus controller used, SATA only or SAS. Each 3.5" hard disk drive is mounted to the chassis bay. A single multi-connector cable is routed from a four port mini-SAS connector on the server board to each hard disk.

5.4 Optical Drive Support

Systems configured with four 3.5" hard drive bays also include a designated drive bay **A** to support a SATA optical drive as illustrated below.

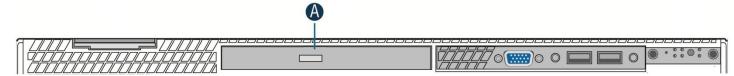


Figure 34. Optical Drive Support

For systems that support eight 2.5" hard drives, the front I/O Panel, which provides video and USB ports, can be replaced with a SATA optical drive.

A 2x3 pin power connector on the server board labeled "ODD/SSD PWR" is designed to provide power to the optical drive. SATA signals for the optical drive are cabled from the white 7-pin single port SATA connector on the server board.

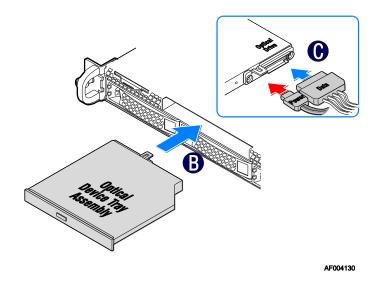


Figure 35. Install a SATA Optical Drive

5.5 SATA DOM Support

The system has support for a vertical low profile Innodisk* SATA Disk-on-Module (DOM) device. The SATA DOM plugs directly into the 7-pin AHCI SATA port 0 on the server board, which provides both power and I/O signals.



Figure 36. Innodisk* SATA Disk-on-Module (DOM) device

SATA DOM features include:

- Ultra Low Profile
- High speed and capacity
- Built-in VCC at pin 7

Note: Visit http://www.intel.com/ for a list of supported InnoDisk SATA DOM parts

6. Storage Controller Options Overview

The server platform supports many different embedded and add-in SATA/SAS controller and SAS Expander options to provide a large number of possible storage configurations. This section will provide an overview of the different options available.

6.1 Embedded SATA/SAS Controller support

Integrated on the server board is an Intel[®] C602 chipset that provides embedded storage support through two integrated controllers: AHCI and SCU.

The standard server board (with no additional storage options installed) will support up to six SATA ports:

- Two 6 Gb/sec SATA port routed from the AHCI controller to two white 7-pin SATA ports labeled "SATA_0" and "SATA_1" on the server board.
- One onboard I/O SAS Module connector.
- Four 3 Gb/sec SAS/SATA ports routed from the SCU controller to the multi-port mini-SAS connector labeled "SCU_0".

Note: The mini-SAS connector labeled "SCU_1" is NOT functional by default and is only enabled with the addition of an Intel[®] RAID C600 Upgrade Key option supporting eight SAS/SATA ports.

With the addition of one of several available Intel[®] RAID C600 Upgrade Keys, the system is capable of supporting additional embedded SATA, SAS, and software RAID options. Upgrade keys install onto a 4-pin connector on the server board labeled "STOR_UPG_KEY".

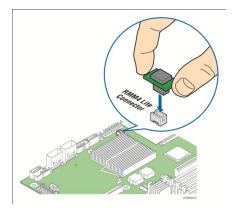


Figure 37. Installing RMM4 Lite Figure

The following table identifies available upgrade key options and their supported features.

Intel [®] RAID C600 Upgrade Key (Intel Product Codes)	Key Color	Description
Default – No option key installed		4 Port SATA with Intel [®] ESRT RAID 0,1,10 and Intel [®] RSTe RAID 0,1,5,10
RKSATA4R5	I BIACK	4 Port SATA with Intel [®] ESRT2 RAID 0,1, 5, 10 and Intel [®] RSTe RAID 0,1,5,10

Table 17. Intel[®] RAID C600 Upgrade Key Options

Intel [®] RAID C600 Upgrade Key (Intel Product Codes)	Key Color	Description
RKSATA8	Blue	8 Port SATA with Intel [®] ESRT2 RAID 0,1, 10 and Intel [®] RSTe RAID 0,1,5,10
RKSATA8R5	White	8 Port SATA with Intel [®] ESRT2 RAID 0,1, 5, 10 and Intel [®] RSTe RAID 0,1,5,10
RKSAS4	Green	4 Port SAS with Intel [®] ESRT2 RAID 0,1, 10 and Intel [®] RSTe RAID 0,1,10
RKSAS4R5	Yellow	4 Port SAS with Intel [®] ESRT2 RAID 0,1, 5, 10 and Intel [®] RSTe RAID 0,1,10
RKSAS8	Orange	8 Port SAS with Intel [®] ESRT2 RAID 0,1, 10 and Intel [®] RSTe RAID 0,1,10
RKSAS8R5	Purple	8 Port SAS with Intel [®] ESRT2 RAID 0,1, 5, 10 and Intel [®] RSTe RAID 0,1,10

Additional information for the on-board RAID features and functionality can be found in the Intel[®] RAID Software Users Guide (Intel Document Number D29305-015).

6.2 Embedded Software RAID Support

The system includes support for two embedded software RAID options:

- Intel[®] Embedded Server RAID Technology 2 (ESRT2) based on LSI* MegaRAID SW RAID technology
- Intel[®] Rapid Storage Technology (RSTe)

Using the <F2> BIOS Setup Utility, accessed during system POST, options are available to enable/disable SW RAID, and select which embedded software RAID option to use.

6.2.1 Intel[®] Embedded Server RAID Technology 2 (ESRT2)¹

Features of the embedded software RAID option Intel[®] Embedded Server RAID Technology 2 (ESRT2) include the following:

- Based on LSI* MegaRAID Software Stack
- Software RAID, with system providing memory and CPU utilization
- Supported RAID Levels 0,1,5,10
 - 4 and 8 Port SATA RAID 5 support provided with appropriate Intel[®] RAID C600 Upgrade Key
 - 4 and 8 Port SAS RAID 5 support provided with appropriate Intel[®] RAID C600 Upgrade Key
- Maximum drive support = 8
 - NOTE: ESRT2 has no SAS Expander Support
 - Open Source Compliance = Binary Driver (includes Partial Source files)
 - Meta data is also recognized by MDRAID layer in Linux (No direct Intel[®] support, not validated by Intel[®])
- OS Support = Windows 7*, Windows 2008*, Windows 2003*, RHEL*, SLES*, other Linux variants using partial source builds.
- Utilities = Windows* GUI and CLI, Linux GUI and CLI, DOS CLI, and EFI CLL

6.2.2 Intel[®] Rapid Storage Technology (RSTe)¹

Features of the embedded software RAID option Intel[®] Rapid Storage Technology (RSTe) include the following:

- Software RAID with system providing memory and CPU utilization
- Supported RAID Levels 0,1,5,10
 - o 4 Port SATA RAID 5 available standard (no option key required)
 - 8 Port SATA RAID 5 support provided with appropriate Intel[®] RAID C600 Upgrade Key
 - No SAS RAID 5 support
- Maximum drive support = 32 (in arrays with 8 port SAS), 16 (in arrays with 4 port SAS), 128 (JBOD)
- Open Source Compliance = Yes (uses MDRAID)
- OS Support = Windows 7*, Windows 2008*, Windows 2003*, RHEL* 1 and later, SLES*1, VMWare 5.x.
- Utilities = Windows* GUI and CLI, Linux CLI, DOS CLI, and EFI CLI
- Note: No boot drive support to targets attached through SAS expander card

Note: See the latest product errata list for support status. Product Errata are documented in the *Intel[®]* Server Board S2400EP, *Intel[®]* Server System R1000EP Monthly Specification Update which can be downloaded from <u>http://www.intel.com/support</u>.

Visit <u>http://www.intel.com/support</u> for a list of supported operating systems.

6.3 Intel[®] Integrated RAID Module Support (Available Option)

The system has support for the Intel[®] Integrated RAID Module RMS25PB080 and RMS25PB040. The RAID module can be installed into any available x8 PCIe add-in slot.

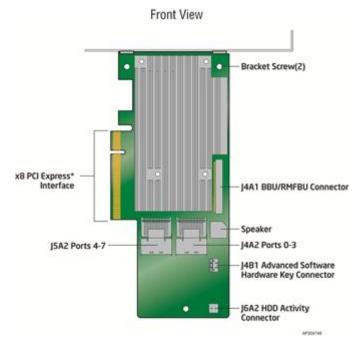


Figure 38. Intel[®] Integrated RAID Module RMS25PB080 and RMS25PB040

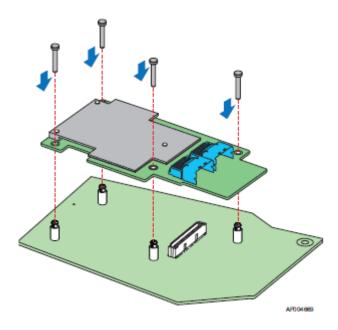


Figure 39. Intel[®] Integrated RAID Module RMS25JB080 and RMS25JB040

Features of this option include:

- SKU options to support full or entry level hardware RAID
- 4 or 8 port and SAS/SATA or SATA –only ROC options
- SKU options to support 512MB or 1GB embedded memory
- Intel[®] designed flash + optional support for super-cap backup (Maintenance Free Back Up) or improved Lithium Polymer battery

Table 18. Supported Intel[®] Integrated RAID Modules

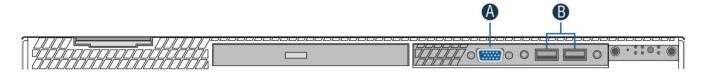
External Name	Description	Product Code
Intel [®] Integrated RAID Module RMS25PB080	8P SAS-2.1, Full HW RAID, 1GB, PCIe	RMS25PB080
Intel [®] Integrated RAID Module RMS25PB040	4P SAS-2.1, Full HW RAID, 1GB, PCIe	RMS25PB040
Intel [®] Integrated RAID Module RMT3PB080	8P SATA-3, Full HW RAID, 512MB, PCIe	RMT3PB080
Intel [®] Integrated RAID Module RMS25JB080	8P SAS-2.1, Entry-level HW RAID, PCIe	RMS25JB080
Intel [®] Integrated RAID Module RMS25JB040	4P SAS-2.1, Entry-level HW RAID, PCIe	RMS25JB040

For additional product information, please refer the following Intel[®] document: Intel[®] Integrated RAID Module RMS25PB080, RMS25PB040, RMS25CB080, and RMS25CB040 Hardware Users Guide – Intel Order Number G37519-001

7. Front Control Panel and I/O Panel Overview

On the front panel of all system configurations is a Control Panel providing push button system controls and LED indicators for several system features, and an I/O Panel providing USB ports and a video connector. This section describes the features and functions of both front panel options.

7.1 I/O Panel Features



Label	Description	
А	Video connector	
В	USB ports	

Figure 40. Front I/O Panel Features

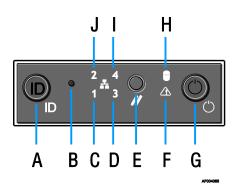
A – Video connector – The front I/O Panel video connector gives the option of attaching a monitor to the front of the system. R1000EP does not support front panel video output.

B – USB Ports – The front I/O panel includes two USB ports. The USB ports are cabled to a 2x5 connector on the server board labeled "FP USB".

Note: On systems that support 8x2.5" hard drives, the I/O Panel can be replaced with a SATA optical drive.

7.2 Control Panel Features

The system includes a control panel that provides push button system controls and LED indicators for several system features. Depending on the hard drive configuration, the front control panel may come in either of two formats; however, both provide the same functionality. This section will provide a description for each front control panel feature.



	Label Description L	.abel	Description
А	System ID Button w/Integrated LED	F	System Status LED
В	NMI Button (recessed, tool required for use)	G	Power/Sleep Button w/Integrated LED
С	NIC-1 Activity LED	Н	Hard Drive Activity LED

D	NIC-3 Activity LED	Ι	NIC-4 Activity LED
Е	System Cold Reset Button	J	NIC-2 Activity LED

Figure 41. Front Control Panel Features

A – System ID Button w/Integrated LED – Toggles the integrated ID LED and the Blue server board ID LED on and off. The System ID LED is used to identify the system for maintenance when installed in a rack of similar server systems. The System ID LED can also be toggled on and off remotely using the IPMI "Chassis Identify" command which will cause the LED to blink for 15 seconds.

B – NMI Button – When the NMI button is pressed, it puts the server in a halt state and issues a non-maskable interrupt (NMI). This can be useful when performing diagnostics for a given issue where a memory download is necessary to help determine the cause of the problem. To prevent an inadvertent system halt, the actual NMI button is located behind the Front Control Panel faceplate where it is only accessible with the use of a small tipped tool like a pin or paper clip.

C, D, I and J - Network Activity LEDs - The Front Control Panel includes an activity LED indicator for each on-board Network Interface Controller (NIC). When a network link is detected, the LED will turn on solid. The LED will blink once network activity occurs at a rate that is consistent with the amount of network activity that is occurring.

E - System Cold Reset Button - When pressed, this button will reboot and re-initialize the system.

F - System Status LED - The System Status LED is a bi-color (Green/Amber) indicator that shows the current health of the server system. The system provides two locations for this feature; one is located on the Front Control Panel, the other is located on the back edge of the server board, viewable from the back of the system. Both LEDs are tied together and will show the same state. The System Status LED states are driven by the on-board platform management sub-system. The following table provides a description of each supported LED state.

Color	State	Criticality	Description			
Off	System is not	Not ready	1. System is powered off (AC and/or DC).			
	operating		2. System is in EuP Lot6 Off Mode.			
			3. System is in S5 Soft-Off State.			
			4. System is in S4 Hibernate Sleep State.			
Green	Solid on	Ok	Indicates that the System is running (in S0 State) and its status is 'He The system is not exhibiting any errors. AC power is present and BM booted and manageability functionality is up and running.			

Table 19. System Status LED State Definitions

Color	State	Criticality	Description
Green	~1 Hz blink	Degraded - system is operating in a degraded state although still functional, <i>or</i> system is operating in a redundant state but with an impending failure warning	 System degraded: Redundancy loss, such as power-supply or fan. Applies only if the associated platform sub-system has redundancy capabilities. Fan warning or failure when the number of fully operational fans is more than minimum number needed to cool the system. Non-critical threshold crossed – Temperature (including HSBP temp), voltage, input power to power supply, output current for main power rail from power supply and Processor Thermal Control (Therm Ctrl) sensors. Power supply predictive failure occurred while redundant power supply configuration was present. Unable to use all of the installed memory (one or more DIMMs failed/disabled but functional memory remains available) Correctable Errors over a threshold and migrating to a spare DIMM (memory sparing). This indicates that the user no longer has spared DIMMs indicating a redundancy lost condition. Corresponding DIMM LED lit. Uncorrectable memory error has occurred in memory Mirroring Mode, causing Loss of Redundancy. Correctable memory error threshold has been reached for a failing DDR3 DIMM when the system is operating in fully redundant RAS Mirroring Mode. Battery failure. BMC executing in uBoot. (Indicated by Chassis ID blinking at Blinking at 3Hz). System in degraded state (no manageability). BMC uBoot is running but has not transferred control to BMC Linux. Server will be in this state 6-8 seconds after BMC reset while it pulls the Linux image into flash BMC booting Linux. (Indicated by Chassis ID solid ON). System in degraded state (no manageability). Control has been passed from BMC uBoot to BMC Linux itself. It will be in this state for ~10-~20 seconds. BMC Watchdog has reset the BMC. Power Unit sensor offset for configuration error is asserted. HDD HSC is off-line or degraded.
Amber	~1 Hz blink	Non-critical - System is operating in a degraded state with an impending failure warning, although still functioning	 Non-fatal alarm – system is likely to fail: Critical threshold crossed – Voltage, temperature (including HSBP temp), input power to power supply, output current for main power rail from power supply and PROCHOT (Therm Ctrl) sensors. VRD Hot asserted. Minimum number of fans to cool the system not present or failed Hard drive fault Power Unit Redundancy sensor – Insufficient resources offset (indicates not enough power supplies present) In non-sparing and non-mirroring mode if the threshold of correctable errors is crossed within the window Correctable memory error threshold has been reached for a failing

Color	State	Criticality	Description		
Amber	Solid on	Critical, non- recoverable –	Fatal alarm – system has failed or shutdown: 1. CPU CATERR signal asserted		
		System is halted	2. MSID mismatch detected (CATERR also asserts for this case).		
			3. CPU 1 is missing		
			4. CPU Thermal Trip		
			5. No power good – power fault		
			 DIMM failure when there is only 1 DIMM present and hence no good memory present¹. 		
			7. Runtime memory uncorrectable error in non-redundant mode.		
			8. DIMM Thermal Trip or equivalent		
			9. SSB Thermal Trip or equivalent		
			10. CPU ERR2 signal asserted		
			11. BMC\Video memory test failed. (Chassis ID shows blue/solid-on for this condition)		
			12. Both uBoot BMC FW images are bad. (Chassis ID shows blue/solid-on for this condition)		
			13. 240VA fault		
			14. Fatal Error in processor initialization:		
			a. Processor family not identical		
			b. Processor model not identical		
			c. Processor core/thread counts not identical		
			d. Processor cache size not identical		
			e. Unable to synchronize processor frequency		
			f. Unable to synchronize QPI link frequency		

G – Power/Sleep Button – Toggles the system power on and off. This button also functions as a sleep button if enabled by an ACPI compliant operating system. Pressing this button will send a signal to the iBMC, which will either power on or power off the system. The integrated LED is a single color (Green) and is capable of supporting different indicator states as defined in the following table.

State	Power Mode	LED	Description
Power-off	Non-ACPI	Off	System power is off, and the BIOS has not initialized the chipset.
Power-on	Non-ACPI	On	System power is on
S5	ACPI	Off	Mechanical is off, and the operating system has not saved any context to the hard disk.
S4	ACPI	Off	Mechanical is off. The operating system has saved context to the hard disk.
S3-S1	ACPI	Slow blink ¹	DC power is still on. The operating system has saved context and gone into a level of low-power state.
S0	ACPI	Steady on	System and the operating system are up and running.

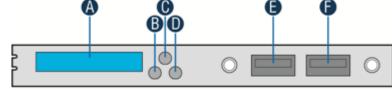
Table 20. Power/Sleep LED Functional States

H- Drive Activity LED - The drive activity LED on the front panel indicates drive activity from the on-board hard disk controllers. The server board also provides a header giving access to this LED for add-in controllers.

8. Intel[®] Local Control Panel

The Intel[®] Local Control Panel option (Intel Product Order Code – **AXXLCPANEL**) utilizes a combination of control buttons and LCD display to provide system accessibility and monitoring.





Label	Description	Functionality			
Α	LCD Display	one line 18 character display			
В	Left Control Button	moves the cursor backward one step or one character			
С	"Enter" Button	selects the menu item highlighted by the cursor			
D	Right Control Button	moves the cursor forward one step or one character			
E	USB 2.0 Port				
F	USB 2.0 Port				

Figure 42. Intel[®] Local Control Panel Option

The LCD (Local Control Display) is a one line character display that resides on the front panel of the chassis. It can display a maximum of 18 characters at a time. This device also contains 3 buttons (Left, Right and Enter). The user can select the content that needs to be displayed on the LCD screen by operating these buttons.

8.1 LCD Functionality

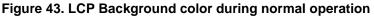
The LCD device provides the following features:

- Displays a banner when the system is healthy. The default banner is the server name.
- Displays active error messages when the system is not healthy.
- Provides basic server management configuration.
- Provides the ability to see asset information without having to open the chassis.

The LCD display is menu driven. Based on the user's selection, respective menu items are displayed. As soon as AC Power is applied to the system, the LCD panel displays faults detected while the system is on standby power prior to DC power on. If there are no faults, a banner is displayed. By default the banner is a text string which displays the "Server Name". The "Server Name" is the value specified as the product name in the product FRU information in the BMC FRU. Users can set any of the parameters under the banner configuration menu as a banner string.

When the system's status is degraded, the corresponding active event will be displayed in place of the banner. During an error, the background color will be light amber in color. The LCD panel displays the event with the highest severity that is most recent and is currently active (that is, in an asserted state). For the case that there are multiple active events with the same severity, the most recent event will be displayed. The LCD panel returns to a light blue background when there are no longer any degraded, non-fatal, or fatal events active. The LCD panel shall operate in lock-step with the system status LED. For example, if the system is operating normally and an event occurs that results in the system status LED to blink green, then the LCD shall display the degraded event that triggered the systems status LED to blink.

Banner



Error

Figure 44. LCP Background color during an error

If the user presses any button after the system is powered on, then the main menu will be displayed. The main menu contains "Error", "View" and "Config" items. Based on the user's selection, respective sub menu items will be displayed. At any point of time, if there is no user intervention for more than 10 min, a default banner (if there is no active error event in the system) or an error event will be displayed.

The following sections discuss the individual menu items. In the following sections, it is assumed that no active event exists during the LCD display. If any event (fatal or non-fatal) occurs that degrades the system's performance, the color of the LCD background turns into light amber. Even though all the contents (full text) are shown in the example screen shots in the following sections, by default, only the first 18 characters are displayed when a particular menu item is selected. The remaining text can be viewed by using right or left buttons.

8.2 Main Menu

If the user presses any button, when the Banner/Error screen is displayed, the following main menu will get displayed. Using left and right scroll buttons, the curser can be moved under any one of the following four menu items.

^ Event View Config

Figure 45. LCP Main Menu

If the user selects menu item, "^", then the LCD displays the previous screen, that is, Banner/Error string. Selecting the menu item means, moving the cursor under that item using left or right buttons and pressing enter button subsequently. In all the following sections (or for any screen shot), if the user presses "Enter" button, when the curser is under the symbol, "^", it takes to the previous screen. Selection of any of the menu items; Event, View or Config, leads the display to their corresponding screen shots and the details of these screen shots are given in the following sections.

8.3 Event Menu

The LCD displays all active error events in human readable text in chronological order. Informational events will not be displayed. There is no upper limit on the number of active events which can be displayed. The severity of the event will be indicated as either "Degraded", "Non-Fatal" or "Fatal".

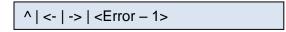


Figure 46. LCP Event Menu

The menu items, "<-" and "->" are used to traverse among the events. Selection of the menu item, "<-", displays the previous event and the item, "->", displays the next event in human readable format. By default the first event after the last power on will be displayed. If there are no events after the last power on, then fourth field is empty on the LCD screen.

By default, each error event scrolls automatically so that the entire error message can be read without pressing either the left or right scroll buttons. To stop auto scrolling, cursor has to be brought under the event message and the right button has to be pressed. Then the screen freezes. To start scrolling again right button has to be pressed when the cursor is under the event message. So, when the cursor is under event message, the right button decides whether to scroll or freeze the display of event message on the screen. When the cursor is under the event message, pressing enter button displays the failing FRU (if any) in an easily human readable format for that error event. Pressing enter button alternatively switches the display between error message and the failing FRU (if any) information of that error message alternatively. If there is no FRU device associated with that error, then enter button has no effect when the cursor is under the error message. Left button moves the cursor under the previous token or menu item, that is, "->".

8.4 View Menu

The following screen is displayed when "View" is selected from the main menu.

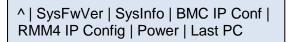


Figure 47. LCP View Menu

Based on the user's selection, details of the specific item will be displayed. The following sub sections explain the above menu items in detail.

8.4.1 System FW Version (SysFwVer)

Selection of the "SysFwVer" item in the "View" menu displays the current firmware versions of the system as shown below:

^ | BIOS = xx.xx | BMC = xx.xx | ME = xx.xx | FRUSDR = xx.xx

Figure 48. System Firmware Versions Menu

This is a leaf node and there is no further traversal below this menu. User can only go to the previous screen by selecting the item, "^". This applies to all the items of "View" menu.

8.4.2 System Information (SysInfo)

Selection of "SysInfo" item in the "View" menu displays the Server's name, model, GUID, asset tag and custom string. It is also a leaf node like above menu. The blanks in the following display will be replaced by their values.

^ Server Name: Server
Model: Asset Tag: Server
GUID: Custom String:

Figure 49. System Information menu

Each of the above fields is explained below:

- 1. **Server Name:** Value specified in the product name in the product FRU information in the main board BMC FRU.
- 2. **Server Model:** Value specified in the product part number in the product FRU information in the main board BMC FRU.
- 3. Asset tag: Value specified in the product asset tag in the product FRU information in the main board BMC FRU.
- 4. Server GUID: System UUID stored by BIOS.
- 5. Custom String: Custom string placed by the OEM\end user.

8.4.3 BMC IP Configuration

Selection of "BMC IP Conf" item in the "View" menu displays the RMM4 IP configuration details. These details show whether the IP is configured using DHCP or Static, IP Address, Subnet Mask and Gateway.

^ DHCP (or Static) IP Address:					
xxx.xxx.xxx.xxx Subnet Mask:					
xxx.xxx.xxx.xxx Gateway:					
XXX.XXX.XXX.XXX	. ,				

Figure 50. LCP – BMC IP Configuration

8.4.4 RMM4 IP Configuration

Selection of "RMM4 IP Conf" item in the "View" menu displays the BMC IP configuration details. These details show whether the IP is configured using DHCP or Static, IP Address, Subnet Mask and Gateway.

^ DHCP (or Static) IP Address:				
xxx.xxx.xxx.xxx Subnet Mask:				
xxx.xxx.xxx.xxx Gateway:				
XXX.XXX.XXX.XXX				

Figure 51. LCP -	RMM4 IP	Configuration
------------------	---------	---------------

8.4.5 Power

Selection of "Power" item in the "View" menu displays the amount of AC power drawn by the system in Watts.

^ | xx W

Figure 52. LCP – Power Consumed by the System Currently

8.4.6 Last Post Code (Last PC)

Selection of "Last PC" item in the "View" menu displays the last BIOS POST code in hexadecimal.

^ | XX (Last BIOS POST Code in Hex)

Figure 53. LCP – Last BIOS Post Code

8.5 Config Menu

If the user selects "Config" item in the main menu, then the following options will be displayed to configure.

^ | IP Version | BMC IP | RMM4 IP | Boot Device | Banner

Figure 54. LCP – Configure Menu Items

The following sub-sections will explain individual items of the configuration menu.

8.5.1 IP Version

If the user selects "IP Version" in the "Config" menu, the following options will be displayed. Based the user's selection, firmware will set the IP Version as either IPv4 or IPv6.

^ | IPv4 | IPv6

Figure 55. LCP – IP Version configuration screen

8.5.2 BMC IP

If the user selects "BMC IP" item, in the "Config" menu then the following options will be displayed.

^ | IP Source | IP Address | Subnet | Gateway

Figure 56. LCP – BMC IP Configuration Menu

Selection of the "IP Source" in the above menu, leads to the following screen. Based on the user's selection in the following menu, the firmware sets the BMC IP source as either DHCP or Static.

^ | DHCP | Static

Figure 57. LCP – BMC IP Source Configuration Menu

If the user selects DHCP or the existing IP source is DHCP, then the other menu items, that is, IP Address, Subnet and Gateway are not configurable. If the user selects "Static" or the existing

setting is static for IP source, then the user is allowed to change the other menu items and the screen shots look as follows:

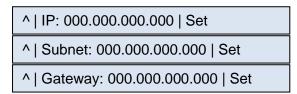


Figure 58. Screen shots for Configuring IP Address, Subnet Mask and Gateway

By default the cursor will be under the symbol, "^" and the IP address is displayed as 000.000.000.000. A right button will take the cursor to the first position (first 0) of the IP address. When the cursor is under the second menu item, the functionality of Left, Right and Enter buttons is different from the previous screens. The second token consists of twelve 0 s' separated by '.' character in IP address format. The behaviors of these buttons are as follows when the cursor is under this item.

- 1. Left and Right buttons inside the second menu item traverses among the 0 positions within the same item.
- 2. If the cursor is under last position inside the second menu item, then a right button will move the cursor to next item, that is, "Set".
- 3. If the cursor is under first position inside the second menu item, then a left button moves the cursor to the previous item, that is, "^".
- 4. First Enter button at any "0" position makes that position to be selected to increment or decrement the value at that position. The values allowed are between and including 0 and 9.
- 5. Any further Left or Right buttons will decrement or increment the value at that position.
- 6. Second Enter button at that position makes the cursor to be ready for moving left or right. Any further Left or Right moves the cursor to previous or next position respectively.
- 7. So, the Enter button is used to select a position at the first time and to leave the position at the second time.

The following state transition diagram explains the above steps pictorially, while setting an IP address using the LCD device. After entering an IP address, the user has to select "Set" item to set the entered IP address to the corresponding parameter (IP Address, Subnet Mask or Gateway).

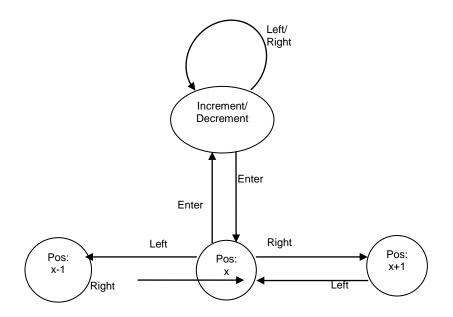


Figure 59. State transition diagram for setting IP Address

8.5.3 RMM4 IP

Same screen shots and the same description as that of the previous section ("BMC IP") are applicable for "RMM4 IP" configuration menu also.

8.5.4 Boot Device

If the user selects "Boot Device" in the "Config" menu, then the following options will be displayed. The selected item will be set as the next boot option and it will not be a permanent change.



Figure 60. Boot options configuration menu

8.5.5 Banner

When the user selects "Banner" in the "Config" menu, the following options will be displayed. The selected item will be set as banner and the same will be displayed from next banner screen onwards.

^ | Server Name | Server Model | Error | BMC IP | RMM4 IP | Power | Last PC | Custom String | Custom Logo

Figure 61. Banner configuration menu

Each of the menu items are explained below:

• Server Name: Displays the value specified in the product name in the product FRU information in the main board BMC FRU. The "Server Name" is the default banner.

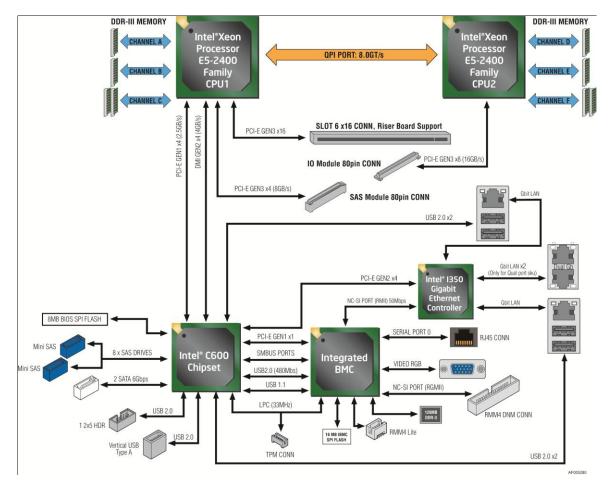
- Server Model: Displays the value specified in the product part number in the product FRU information in the main board BMC FRU.
- Error: Displays the last active system event. The last active event may be degraded, noncritical or critical only. It will not display an informational message. If the system is healthy then displays "System Health Ok".
- **BMC IP:** Displays the IPv4 or IPv6 address of BMC IP. If the BMC IP address is not configured, then nothing is displayed.
- **RMM4 IP:** Displays the IPv4 or IPv6 address of RMM4 dedicated LAN IP. If the RMM4 IP is not set or not present, then nothing is displayed.
- **Power:** Displays the current system power consumption in watts. The power consumed will be refreshed every minute.
- Last PC: Displays last BIOS post code.
- **Custom string:** Displays a customizable text string. The custom text string is modifiable through BIOS setup.
- **Custom Logo:** Displays a customizable bitmap logo. The OEM customized logo is programmed by the OEM and will be maintained during subsequent firmware updates.

9. PCI Riser Card Support

The system includes one riser card slot on the server board. This section will provide an overview of the available riser card and describe the server board features and architecture supporting them.

9.1 Architectural Overview of the Server Board Riser Slot

The server board includes one riser card slot labeled "Slot_6". The following diagrams illustrate the general server board architecture supporting these two slots.





CPU #1 provides Riser Slot #6 with x16 PCIe bus lanes.

9.2 Riser Card Support

The riser card is mounted to a bracket assembly and is installed into the system by aligning the edge connector of the riser card with the matching slot connector on the server board, and with hooks on the bracket assembly to slots on the back edge of the chassis.

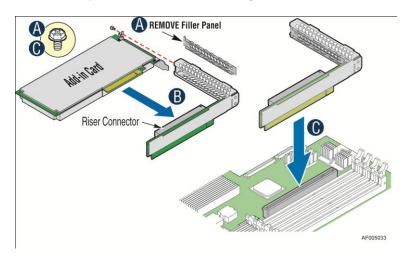


Figure 63. Add-in Card Support

10. Mezzanine Module Support

10.1 I/O Module Support

In addition to the embedded I/O features of the server board, and those available with the addition of a PCIe add-in card, the server also provides concurrent support of an optionally installed mezzanine I/O module.

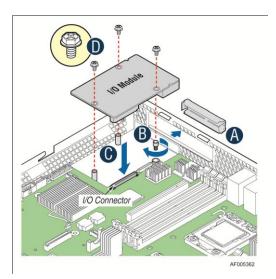


Figure 64. Installing I/O Module

The following table lists the Intel[®] I/O modules available for this server:

Table 21	. Intel [®] I/O	Modules	Available	for Server	System R	1000EP

Product Code and IPN	Description
AXX10GBNIAIOM	Dual SFP+ port 10GbE IO Module based on Intel [®] 82599 10GbE Ethernet Controller
AXX10GBTWLIOM	Dual RJ45 Port, 10GBASE-T IO Module, based on Intel [®] I350 Ethernet chipset
AXX1FDRIBIOM	Single Port, FDR speed Infiniband module, with QSFP connector
AXX4P1GBPWLIOM	Quad Port 1GbE 1o Module based on Intel [®] Ethernet Controller I350
AXXQAAIOMOD	Intel [®] Quick Assist Accelerator IO Mezzanine Card

Caution: I/O Module and RMM4 are mutually exclusive due to mechanical conflict in Intel[®] Server System R1000EP.

10.2 Intel[®] Remote Management Module 4 (RMM4) Lite and Management NIC Support

The integrated baseboard management controller has support for advanced management features which are enabled when an optional Intel[®] Remote Management Module 4 (RMM4) is installed.

RMM4 is comprised of two boards – RMM4 lite and the optional Dedicated Server Management NIC (DMN).

Intel Product Code	Description	Kit Contents	Benefits
AXXRMM4LITE	Intel [®] Remote Management Module 4 Lite	RMM4 Lite Activation Key	Enables KVM and media redirection through onboard NIC
AXXRMM4R	Intel [®] Remote Management Module 4	RMM4 Lite Activation Key Dedicated NIC Port Module	Dedicated NIC for management traffic. Higher bandwidth connectivity for KVM and media Redirection with 1Gbe NIC.

Table 22. Supported Intel[®] Remote Management Module

On the server board each Intel[®] RMM4 component is installed at the following locations.

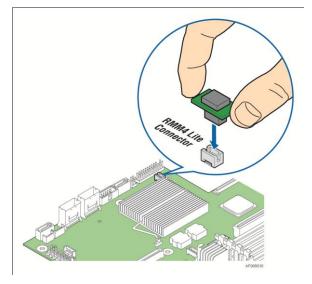


Figure 65. Intel[®] RMM4 Lite Activation Key Installation

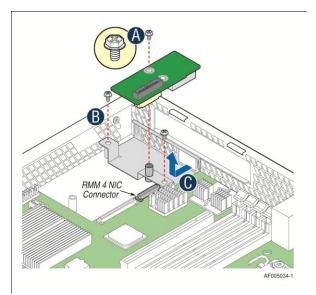


Figure 66. Intel[®] RMM4 Dedicated Management NIC Installation

Manageability Hardware	Benefits
Intel [®] Integrated BMC	Comprehensive IPMI based base manageability features
Intel [®] Remote Management Module 4 – Lite Package contains one module – 1- Key for advance Manageability features.	No dedicated NIC for management Enables KVM and media redirection through onboard NIC
Intel [®] Remote Management Module 4 Package includes two modules – 1 - key for advance features 2 - Dedicated NIC (1Gbe) for management	Dedicated NIC for management traffic. Higher bandwidth connectivity for KVM and media Redirection with 1Gbe NIC.

Table 23. Enabling Advanced Management Features

For further RMM4 information, please refer to the following documents:

- Intel[®] Server Board S2400EP Technical Product Specification
- Intel[®] Remote Management Module 4 Technical Product Specification
- Intel[®] Remote Management Module 4 and Integrated BMC Web Console Users Guide

Appendix A: Integration and Usage Tips

This section provides a list of useful information that is unique to the Intel[®] Server System R1000EP Product Family and should be kept in mind while configuring your server system.

- Only the Intel[®] Xeon[®] processor E5-2400 product family is supported in this Intel[®] server system. Previous generation Intel[®] Xeon[®] processors are not supported.
- For best system performance, follow memory population guidelines as specified in the Intel[®] Server Board S2400EP Technical Product Specification.
- For best system performance, follow all thermal configuration guidelines as specified in this document.
- The Mini-SAS connector labeled "SCU_1" on the server board is only functional when an appropriate Intel[®] RAID C600 Upgrade Key is installed.
- Many integrated on-board SAS and RAID options are available by installing any of several available Intel[®] RAID C600 Upgrade Keys.
- Intel[®] I/O Module and Intel[®] RMM4 module are mutually exclusive due to mechanical conflict in Intel[®] Server System R1000EP.
- The embedded platform management system may not operate as expected if the platform is not updated with accurate system configuration data. The FRUSDR utility must be run with the system fully configured and each time the system configuration changes for accurate system monitoring and event reporting.
- Make sure the latest system software is loaded on the server. This includes System BIOS, BMC Firmware, ME Firmware and FRU & SDR data. The latest system software can be downloaded from <u>http://www.intel.com/support</u>.

Appendix B: POST Code Diagnostic LED Decoder

Appendix B: POST Code Diagnostic LED Decoder

As an aid to assist in trouble shooting a system hang that occurs during a system's Power-On Self Test (POST) process, the server board includes a bank of eight POST Code Diagnostic LEDs on the back edge of the server board.

During the system boot process, Memory Reference Code (MRC) and System BIOS execute a number of memory initialization and platform configuration processes, each of which is assigned a specific hex POST code number. As each routine is started, the given POST code number is displayed to the POST Code Diagnostic LEDs on the back edge of the server board.

During a POST system hang, the displayed post code can be used to identify the last POST routine that was run prior to the error occurring, helping to isolate the possible cause of the hang condition.

Each POST code is represented by eight LEDs; four Green and four Amber. The POST codes are divided into two nibbles, an upper nibble and a lower nibble. The upper nibble bits are represented by Amber Diagnostic LEDs #4, #5, #6, #7. The lower nibble bits are represented by Green Diagnostics LEDs #0, #1, #2 and #3. If the bit is set in the upper and lower nibbles, the corresponding LED is lit. If the bit is clear, the corresponding LED is off.

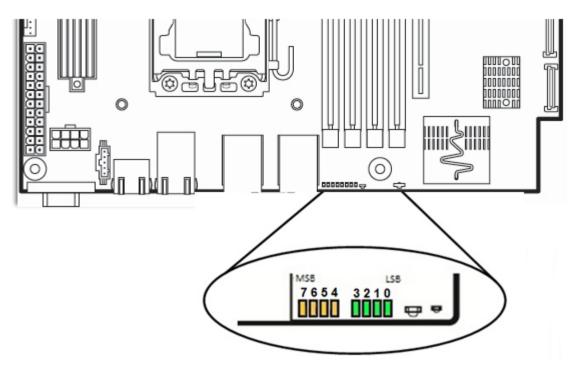


Figure 67. POST Diagnostic LEDs

Appendix B: POST Code Diagnostic LED Decoder

In the following example, the BIOS sends a value of ACh to the diagnostic LED decoder. The LEDs are decoded as follows:

		Upper Nibble	AMBER LEDs		Lower Nibble GREEN LEDs			
	MSB							LSB
LEDs	LED #7	LED #6	LED #5	LED #4	LED #3	LED #2	LED #1	LED #0
	8h	4h	2h	1h	8h	4h	2h	1h
Status	ON	OFF	ON	OFF	ON	ON	OFF	OFF
Results	1	0	1	0	1	1	0	0
Results		A	h		Ch			

Table 24. POST Progress Code LED Example

Upper nibble bits = 1010b = Ah; Lower nibble bits = 1100b = Ch; the two are concatenated as ACh.

		D	iaano	ostic l	_ED D	ecod	ег					
					0 = L							
Checkszint			Nibbl				r Nibb					
Checkpoint		pper	וטטויו	e	L	Lowe	i inidl I	-	Description			
	MSB							LSB				
	8h	4h	2h	1h	8h	4h	2h	1h				
LED #	#7	#6	#5	#4	#3	#2	#1	#0				
SEC Phase												
01h	0	0	0	0	0	0	0	1	First POST code after CPU reset			
02h	0	0	0	0	0	0	1	0	Microcode load begin			
	0	0	0	0		0	1	1	CRAM initialization begin			
	0	0	0	0	0	1	0	0	Pei Cache When Disabled			
	0	0	0	0	0	1	0	1	SEC Core At Power On Begin.			
	0	0	0	0	0	1	1	0	Early CPU initialization during Sec Phase.			
	0	0	0	0	0	1	1	1	Early SB initialization during Sec Phase.			
	0	0	0	0	1	0	0	0	Early NB initialization during Sec Phase.			
09h	0	0	0	0	1	0	0	1	End Of Sec Phase.			
	0	0	0	0	1	0 1	1	0	Microcode Not Found.			
	-	-		-								
• • • •	0	0	0	0	1	1	1	1	Microcode Not Loaded.			
PEI Phase	0	•										
	0	0	0	1	0	0	0	0	PEI Core			
	0	0	0	1		0	0	1	CPU PEIM			
-	0	0	0	1	0	1	0	1	NB PEIM			
	0	0	0	1		0	0	1	SB PEIM			
MRC Proces	s Co	des -	- MR	C Pr	ogre	ss C	ode \$	Sequ	ence is executed - See Table 63			
PEI Phase c	ontinu	beu										
31h	0	0	1	1	0	0	0	1	Memory Installed			
	0	0	1	1		0	1	0	CPU PEIM (Cpu Init)			
	0	0	1	1		0	1	1	CPU PEIM (Cache Init)			
	0	0	1	1	0	1	0	0	CPU PEIM (BSP Select)			
	0	0	1	1	0	1	0	1	CPU PEIM (AP Init)			
	0	0	1	1	0	1	1	0	CPU PEIM (CPU SMM Init)			
	0	1	0	0	1	1	1	1	Dxe IPL started			
DXE Phase	0		0	0					Die II E Statted			
	0	1	1	0	0	Δ		0	DXE Core started			
	0	1 1	1 1	0 0	0 0	0 0	0 0	0 1	DXE NVRAM Init			
-	0	1	1	0		0	1	0	SB RUN Init			
63h	0	1	1	0	0	0	1	1	Dxe CPU Init			
	0	1	1	0		0	0	0	DXE PCI Host Bridge Init			
	0	1	1	0		0	0	1	DXE NB Init			
	0	1	1	0		0		0	DXE NB SMM Init			
	0	1	1	1		0		0	DXE SB Init			
71h	0	1	1	1		0	0	1	DXE SB SMM Init			
72h	0	1	1	1		0	1	0	DXE SB devices Init			
78h	0	1	1	1	1	0	0	0	DXE ACPI Init			
	0	1	1	1		0	0	1	DXE CSM Init			
90h	1	0	0	1		0	0	0	DXE BDS Started			
91h	1	0	0	1		0	0	1	DXE BDS connect drivers			
92h	1	0	0	1		0	1	0	DXE PCI Bus begin			
93h	1	0	0	1		0	1	1	DXE PCI Bus HPC Init			
93h 94h	1	0	0	1	0	1	0	0	DXE PCI Bus enumeration			
9411 95h	1	0	0	1 1	0	1 1	0	1	DXE PCI Bus enumeration DXE PCI Bus resource requested			
	1		-		-							
96h	1	0	0	1	0	1	1	0	DXE PCI Bus assign resource			
97h	1	0	0	1	0	1	1	1	DXE CON_OUT connect			
98h	1	0	0	1	1	0	0	0	DXE CON_IN connect			
99h	1	0	0	1		0	0	1	DXE SIO Init			
9Ah	1	0	0	1	1	0	1	0	DXE USB start			
9Bh	1	0	0	1	1	0	1	1	DXE USB reset			
9Ch	1	0	0	1	1	1	0	0	DXE USB detect			
									· · · · · · · · · · · · · · · · · · ·			

Table 25. Diagnostic LED POST Code Decoder

Intel[®] Server System R1000EP Product Family TPS Appendix B: POST Code Diagnostic LED Decoder

					ecode			-			
MSB Image: MSSB Image: MSSB </td <td></td>											
MSB Image: Constraint of the state of the s		Description		⁻ Nibb	ower	<u> </u>	9	Nibble	pper l	U	Checkpoint
LED # #7 #6 #5 #4 #3 #2 #1 #0 9Dh 1 0 0 1 1 0 1 DXE USB enable A1h 1 0 1 0 0 0 1 DXE IDE begin A2h 1 0 1 0 0 0 1 DXE IDE reset A3h 1 0 1 0 0 1 1 DXE IDE reset A4h 1 0 1 0 0 1 0 DXE IDE enable A5h 1 0 1 0 0 1 DXE SCSI begin A6h 1 0 1 0 0 1 DXE SCSI reset A7h 1 0 1 0 0 D DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1										MSB	
9Dh 1 0 1 1 1 0 1 DXE USB enable A1h 1 0 1 0 0 0 1 DXE IDE begin A2h 1 0 1 0 0 0 1 DXE IDE reset A3h 1 0 1 0 0 1 1 DXE IDE detect A4h 1 0 1 0 0 1 DXE IDE enable A5h 1 0 1 0 0 1 DXE SCSI begin A6h 1 0 1 0 0 1 1 DXE SCSI begin A6h 1 0 1 0 0 1 1 DXE SCSI begin A6h 1 0 1 0 DXE SCSI detect A8h 1 0 1 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A8h A8h 1 0 1 DXE SCSI begin SCSI begin A8h A				2h	4h	8h	1h	2h	4h	8h	
A1h 1 0 1 0 0 0 1 DXE IDE begin A2h 1 0 1 0 0 0 1 0 DXE IDE reset A3h 1 0 1 0 0 1 1 DXE IDE detect A4h 1 0 1 0 0 1 0 DXE IDE enable A5h 1 0 1 0 0 1 0 DXE SCSI begin A6h 1 0 1 0 0 1 1 DXE SCSI begin A7h 1 0 1 0 0 1 1 DXE SCSI reset A7h 1 0 1 0 0 DXE SCSI detect A8h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SETUP password ABh 1 0 1 0<			#0	#1	#2	#3	#4	#5	#6	#7	LED #
A2h 1 0 1 0 0 1 0 DXE IDE reset A3h 1 0 1 0 0 1 1 DXE IDE detect A4h 1 0 1 0 0 1 0 DXE IDE enable A5h 1 0 1 0 0 1 DXE SCSI begin A6h 1 0 1 0 0 1 1 DXE SCSI reset A7h 1 0 1 0 0 1 1 DXE SCSI reset A8h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SETUP password ABh 1 0 1 0 0 DXE SETUP start ACh 1 0 1 1 0 DXE Ready to Boot AEh 1 0 1 1 0 DXE Legacy Boot		DXE USB enable	1	0	1	1	1	0	0	1	9Dh
A3h 1 0 1 0 0 1 1 DXE IDE detect A4h 1 0 1 0 0 1 0 DXE IDE enable A5h 1 0 1 0 0 1 DXE SCSI begin A6h 1 0 1 0 0 1 1 DXE SCSI reset A7h 1 0 1 0 0 1 1 DXE SCSI detect A8h 1 0 1 0 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE settil enable ACh 1 0 1 0 0 DXE settil enable ADh 1 0 1 0 DXE settil enable 0 ACh 1 0 1 0 DXE settil enable 0		DXE IDE begin	1	0	0	0	0	1	0	1	A1h
A4h 1 0 1 0 0 DXE IDE enable A5h 1 0 1 0 1 DXE SCSI begin A6h 1 0 1 0 1 0 DXE SCSI reset A7h 1 0 1 0 1 1 DXE SCSI detect A8h 1 0 1 0 0 1 1 DXE SCSI enable A9h 1 0 1 0 0 1 DXE SCSI enable A9h 1 0 1 0 0 1 DXE SCSI enable A9h 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 DXE verifying SETUP password ABh 1 0 1 0 1 DXE SETUP start ACh 1 0 1 1 DXE Ready to Boot AEh 1 0 1 1 DXE Legacy Boot AFh 1 0 1 1		DXE IDE reset	0	1	0	0	0	1	0	1	A2h
A5h 1 0 1 0 1 DXE SCSI begin A6h 1 0 1 0 0 1 1 0 DXE SCSI begin A7h 1 0 1 0 0 1 1 DXE SCSI reset A8h 1 0 1 0 0 0 DXE SCSI detect A8h 1 0 1 0 0 0 DXE SCSI enable A9h 1 0 1 0 0 0 DXE SCSI enable A9h 1 0 1 0 0 1 DXE seccently password ABh 1 0 1 0 1 DXE secretly start ACh 1 0 1 1 DXE Ready to Boot AEh 1 0 1 1 DXE tegacy Boot AFh 1 0 1 1 DXE tegacy Boot AFh 1 0 1 1 DXE tegacy Map Begin B0h 1 0 1 <t< td=""><td></td><td>DXE IDE detect</td><td>1</td><td>1</td><td>0</td><td>0</td><td>0</td><td>1</td><td>0</td><td>1</td><td>A3h</td></t<>		DXE IDE detect	1	1	0	0	0	1	0	1	A3h
A6h 1 0 1 1 0 DXE SCSI reset A7h 1 0 1 0 1 1 DXE SCSI detect A8h 1 0 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 0 0 DXE verifying SETUP password ABh 1 0 1 0 1 0 1 DXE verifying SETUP password ABh 1 0 1 0 1 DXE SETUP start ACh 1 0 1 1 0 DXE Ready to Boot AEh 1 0 1 1 0 DXE Legacy Boot AFh 1 0 1 1 DXE Exit Boot Services B0h 1 0 1 1 DXE Exit Boot Services B0h 1 0 1 0 0 RT Set Virtual Address Map Begin B1h 1 0 0 0 1 RT Set Virtual Address Map End		DXE IDE enable	0	0	1	0	0	1	0	1	A4h
A7h 1 0 1 1 1 DXE SCSI detect A8h 1 0 1 0 1 0 0 DXE SCSI enable A9h 1 0 1 0 1 0 0 DXE Verifying SETUP password ABh 1 0 1 0 1 1 DXE SETUP start ACh 1 0 1 1 0 0 DXE SETUP input wait ADh 1 0 1 1 0 1 DXE Ready to Boot AEh 1 0 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 1 1 RT Set Virtual Address Map Begin B1h 1 0 1 1 RT Set Virtual Address Map End		DXE SCSI begin	1	0	1	0	0	1	0	1	A5h
A8h 1 0 1 0 0 0 DXE SCSI enable A9h 1 0 1 0 0 1 DXE verifying SETUP password ABh 1 0 1 0 1 1 DXE SETUP start ACh 1 0 1 1 0 0 DXE SETUP input wait ADh 1 0 1 1 0 1 DXE Ready to Boot AEh 1 0 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 1 1 DXE Set Virtual Address Map Begin B1h 1 0 1 1 RT Set Virtual Address Map End		DXE SCSI reset	0	1	1	0	0	1	0	1	
A9h 1 0 1 0 1 0 XE verifying SETUP password ABh 1 0 1 0 1 1 DXE SETUP start ACh 1 0 1 0 1 1 DXE SETUP input wait ADh 1 0 1 1 0 1 DXE Ready to Boot AEh 1 0 1 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 1 1 DXE Set Virtual Address Map Begin B1h 1 0 1 1 RT Set Virtual Address Map End			1	1	1	0	0	1	0	1	
ABh 1 0 1 0 1 1 DXE SETUP start ACh 1 0 1 0 0 DXE SETUP input wait ADh 1 0 1 1 0 0 DXE Ready to Boot AEh 1 0 1 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 1 1 RT Set Virtual Address Map Begin B1h 1 0 1 1 RT Set Virtual Address Map End			0	0	0	1	0	1	0	1	A8h
ABh 1 0 1 0 1 1 DXE SETUP start ACh 1 0 1 0 0 DXE SETUP input wait ADh 1 0 1 1 0 0 DXE Ready to Boot AEh 1 0 1 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 1 1 RT Set Virtual Address Map Begin B1h 1 0 1 1 RT Set Virtual Address Map End		DXE verifying SETUP password	1	0	0	1	0	1	0	1	A9h
ADh 1 0 1 1 0 1 DXE Ready to Boot AEh 1 0 1 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 0 DXE Legacy Boot B0h 1 0 1 1 1 DXE Exit Boot Services B1h 1 0 1 0 0 0 RT Set Virtual Address Map Begin			1	1	0	1	0	1	0	1	ABh
AEh 1 0 1 1 1 0 DXE Legacy Boot AFh 1 0 1 1 1 1 DXE Legacy Boot B0h 1 0 1 1 1 1 DXE Exit Boot Services B0h 1 0 1 0 0 0 RT Set Virtual Address Map Begin B1h 1 0 1 0 0 0 1 RT Set Virtual Address Map End		DXE SETUP input wait	0	0	1	1			0	1	ACh
AFh 1 0 1 1 1 DXE Exit Boot Services B0h 1 0 1 0 0 0 RT Set Virtual Address Map Begin B1h 1 0 1 0 0 0 1 RT Set Virtual Address Map Begin		DXE Ready to Boot	1	0	1	1	0	1	0	1	ADh
B0h 1 0 1 0 0 0 RT Set Virtual Address Map Begin B1h 1 0 1 0 0 1 RT Set Virtual Address Map Begin		DXE Legacy Boot	0	1	1	1	0	1	0	1	AEh
B1h 1 0 1 1 0 0 0 1 RT Set Virtual Address Map End		DXE Exit Boot Services	1	1	1	1	0	1	0	1	AFh
		RT Set Virtual Address Map Begin	0	0	0	0	1	1	0	1	B0h
		RT Set Virtual Address Map End	1	0	0	0	1	1	0	1	B1h
B2h 1 0 1 1 0 0 1 0 DXE Legacy Option ROM init		DXE Legacy Option ROM init	0	1	0	0	1	1	0	1	B2h
B3h 1 0 1 1 0 0 1 1 DXE Reset system			1	1	0	0	1	1	0	1	B3h
B4h 1 0 1 1 0 1 0 DXE USB Hot plug		DXE USB Hot plug	0	0	1	0	1	1	0	1	B4h
B5h 1 0 1 1 0 1 0 1 DXE PCI BUS Hot plug		DXE PCI BUS Hot plug	1	0	1	0	1	1	0	1	B5h
B6h 1 0 1 1 0 1 1 0 DXE NVRAM cleanup		DXE NVRAM cleanup	0	1	1	0	1	1	0	1	B6h
B7h 1 0 1 1 0 1 1 DXE Configuration Reset		DXE Configuration Reset	1	1	1	0	1	1	0	1	B7h
00h 0 0 0 0 0 0 0 INT19		INT19	0	0	0	0	0	0	0	0	00h
S3 Resume											S3 Resume
E0h 1 1 0 1 0 0 0 S3 Resume PEIM (S3 started)		S3 Resume PEIM (S3 started)	0	0	0		1	0	1	1	E0h
E1h 1 1 0 1 0 0 0 1 S3 Resume PEIM (S3 boot script)		S3 Resume PEIM (S3 boot script)	1	0	0	0	1	0	1	1	E1h
E2h 1 1 0 1 0 1 0 S3 Resume PEIM (S3 Video Repost)		S3 Resume PEIM (S3 Video Repost)	0	1	0	0	1	0	1	1	E2h
E3h 1 1 0 1 0 0 1 1 S3 Resume PEIM (S3 OS wake)				1	0	0	1	0	1	1	E3h
BIOS Recovery										ery	BIOS Recov
F0h 1 1 1 0 0 0 PEIM which detected forced Recovery condition		PEIM which detected forced Recovery condition	0	0				1	1	1	
F1h 1 1 1 0 0 0 PEIM which detected User Recovery condition		PEIM which detected User Recovery condition	1	0			1	1	1	1	
F2h 1 1 1 0 0 1 0 Recovery PEIM (Recovery started)			0	1	0	0	1	1	1	1	
F3h 1 1 1 0 0 1 1 Recovery PEIM (Capsule found)			1	1	0	0	1	1	1	1	F3h
F4h 1 1 1 1 0 1 0 Recovery PEIM (Capsule loaded)			0	0	1	0	1	1	1	1	F4h

POST Memory Initialization MRC Diagnostic Codes

There are two types of POST Diagnostic Codes displayed by the MRC during memory initialization; Progress Codes and Fatal Error Codes.

The MRC Progress Codes are displays to the Diagnostic LEDs that show the execution point in the MRC operational path at each step.

	Diagnostic LED Decoder									
		1 =	LED) On,	0 =	LED	Off			
Checkpoint	Upper Nibble				Lower Nibble		ble	Description		
	MSB							LSB	Description	
	8h	4h	2h	1h	8h	4h	2h	1h		
LED	#7	#6	#5	#4	#3	#2	#1	#0		
MRC Progress Codes										
B0h	1	0	1	1	0	0	0	0	Detect DIMM population	
B1h	1	0	1	1	0	0	0	1	Set DDR3 frequency	
B2h	1	0	1	1	0	0	1	0	Gather remaining SPD data	
B3h	1	0	1	1	0	0	1	1	Program registers on the memory controller level	
B4h	1	0	1	1	0	1	0	0	Evaluate RAS modes and save rank information	
B5h	1	0	1	1	0	1	0	1	Program registers on the channel level	
B6h	1	0	1	1	0	1	1	0	Perform the JEDEC defined initialization sequence	
B7h	1	0	1	1	0	1	1	1	Train DDR3 ranks	
B8h	1	0	1	1	1	0	0	0	Initialize CLTT/OLTT	
B9h	1	0	1	1	1	0	0	1	Hardware memory test and init	
BAh	1	0	1	1	1	0	1	0	Execute software memory init	
BBh	1	0	1	1	1	0	1	1	Program memory map and interleaving	
BCh	1	0	1	1	1	1	0	0	Program RAS configuration	
BFh	1	0	1	1	1	1	1	1	MRC is done	

Table	26.	MRC	Progress	Codes
Iabio	20.		11091000	00400

Memory Initialization at the beginning of POST includes multiple functions, including: discovery, channel training, validation that the DIMM population is acceptable and functional, initialization of the IMC and other hardware settings, and initialization of applicable RAS configurations.

When a major memory initialization error occurs and prevents the system from booting with data integrity, a beep code is generated, the MRC will display a fatal error code on the diagnostic LEDs, and a system halt command is executed. Fatal MRC error halts do NOT change the state of the System Status LED, and they do NOT get logged as SEL events. The following table lists all MRC fatal errors that are displayed to the Diagnostic LEDs.

			Diagr	nostic l	_ED De	ecoder			
			1 = L	ED On,	0 = LE	D Off			
Checkpoint		Upper	Nibble	j	Lower Nibble				
	MSB							LSB	Description
	8h	4h	2h	1h	8h	4h	2h	1h	
LED	#7	#6	#5	#4	#3	#2	#1	#0	
MRC Fatal E	rror C	odes							
E8h	1	1	1	0	1	0	0	0	No usable memory error 01h = No memory was detected through SPD read, or invalid config that causes no operable memory. 02h = Memory DIMMs on all channels of all sockets are disabled due to hardware memtest error. 3h = No memory installed. All channels are disabled.
E9h	1	1	1	0	1	0	0	1	Memory is locked by Intel [®] Trusted Execuiton Technology and is inaccessible
EAh	1	1	1	0	1	0	1	0	DDR3 channel training error 01h = Error on read DQ/DQS (Data/Data Strobe) init 02h = Error on Receive Enable 3h = Error on Write Leveling 04h = Error on write DQ/DQS (Data/Data Strobe
EBh	1	1	1	0	1	0	1	1	Memory test failure 01h = Software memtest failure. 02h = Hardware memtest failed. 03h = Hardware Memtest failure in Lockstep Channel mode requiring a channel to be disabled. <i>This is a fatal</i> <i>error which requires a reset and calling MRC with a</i> <i>different RAS mode to retry.</i>
EDh	1	1	1	0	1	1	0	1	DIMM configuration population error 01h = Different DIMM types (UDIMM, RDIMM, LRDIMM) are detected installed in the system. 02h = Violation of DIMM population rules. 03h = The 3rd DIMM slot cannot be populated when QR DIMMs are installed. 04h = UDIMMs are not supported in the 3rd DIMM slot. 05h = Unsupported DIMM Voltage.
EFh	1	1	1	0	1	1	1	1	Indicates a CLTT table structure error

Table 27. MRC Fatal Error Codes

Appendix C: POST Code Errors

- Most error conditions encountered during POST are reported using POST Error Codes. These codes represent specific failures, warnings, or are informational. POST Error Codes may be displayed in the Error Manager display screen, and are always logged to the System Event Log (SEL). Logged events are available to System Management applications, including Remote and Out of Band (OOB) management.
- There are exception cases in early initialization where system resources are not adequately initialized for handling POST Error Code reporting. These cases are primarily Fatal Error conditions resulting from initialization of processors and memory, and they are handed by a Diagnostic LED display with a system halt.
- The following table lists the supported POST Error Codes. Each error code is assigned an error type which determines the action the BIOS will take when the error is encountered. Error types include Minor, Major, and Fatal. The BIOS action for each is defined as follows:
- Minor: The error message is displayed on the screen or on the Error Manager screen, and an error is logged to the SEL. The system continues booting in a degraded state. The user may want to replace the erroneous unit. The POST Error Pause option setting in the BIOS setup does not have any effect on this error.
- Major: The error message is displayed on the Error Manager screen, and an error is logged to the SEL. The POST Error Pause option setting in the BIOS setup determines whether the system pauses to the Error Manager for this type of error so the user can take immediate corrective action or the system continues booting.

Note that for 0048 "Password check failed", the system halts, and then after the next reset/reboot will displays the error code on the Error Manager screen.

 Fatal: The system halts during post at a blank screen with the text "Unrecoverable fatal error found. System will not boot until the error is resolved" and "Press <F2> to enter setup" The POST Error Pause option setting in the BIOS setup does not have any effect with this class of error.

When the operator presses the **F2** key on the keyboard, the error message is displayed on the Error Manager screen, and an error is logged to the SEL with the error code. The system cannot boot unless the error is resolved. The user needs to replace the faulty part and restart the system.

Note: The POST error codes in the following table are common to all current generation Intel[®] server platforms. Features present on a given server board/system will determine which of the listed error codes are supported.

Error Code	Error Message	Response
0012	System RTC date/time not set	Major
0048	Password check failed	Major
0140	PCI component encountered a PERR error	Major
0141	PCI resource conflict	Major
0146	PCI out of resources error	Major
0191	Processor core/thread count mismatch detected	Fatal
0192	Processor cache size mismatch detected	Fatal
0194	Processor family mismatch detected	Fatal
0195	Processor Intel [®] QPI link frequencies unable to synchronize	Fatal
0196	Processor model mismatch detected	Fatal

Table 28. POST Error Messages and Handling

Error Code	Error Message	Response
0197	Processor frequencies unable to synchronize	Fatal
5220	BIOS Settings reset to default settings	Major
5221	Passwords cleared by jumper	Major
5224	Password clear jumper is Set	Major
8130	Processor 01 disabled	Major
8131	Processor 02 disabled	Major
8132	Processor 03 disabled	Major
8133	Processor 04 disabled	Major
8160	Processor 01 unable to apply microcode update	Major
8161	Processor 02 unable to apply microcode update	Major
8162	Processor 03 unable to apply microcode update	Major
8163	Processor 04 unable to apply microcode update	Major
8170	Processor 01 failed Self Test (BIST)	Major
8171	Processor 02 failed Self Test (BIST)	Major
8172	Processor 03 failed Self Test (BIST)	Major
8173	Processor 04 failed Self Test (BIST)	Major
8180	Processor 01 microcode update not found	Minor
8181	Processor 02 microcode update not found	Minor
3182	Processor 03 microcode update not found	Minor
8183	Processor 04 microcode update not found	Minor
8190	Watchdog timer failed on last boot	Major
8198	OS boot watchdog timer failure	Major
8300	Baseboard management controller failed self-test	Major
8305	Hot Swap Controller failure	Major
83A0	Management Engine (ME) failed Selftest	Major
83A1	Management Engine (ME) Failed to respond.	Major
84F2	Baseboard management controller failed to respond	Major
84F3	Baseboard management controller in update mode	Major
84F4	Sensor data record empty	Major
84FF	System event log full	Minor
8500	Memory component could not be configured in the selected RAS mode	Major
8501	DIMM Population Error	Major
8520	DIMM_A1 failed test/initialization	Major
8521	DIMM_A2 failed test/initialization	Major
8522	DIMM_A3 failed test/initialization	Major
8523	DIMM_B1 failed test/initialization	Major
8524	DIMM_B2 failed test/initialization	Major
8525	DIMM_B3 failed test/initialization	Major
8526	DIMM_C1 failed test/initialization	Major
8527	DIMM_C2 failed test/initialization	Major
8528	DIMM C3 failed test/initialization	Major
8529	DIMM D1 failed test/initialization	Major
852A	DIMM_D2 failed test/initialization	Major
852B	DIMM D3 failed test/initialization	Major
852C	DIMM_E1 failed test/initialization	Major
852D	DIMM_E2 failed test/initialization	Major
852E	DIMM_E3 failed test/initialization	Major
852F	DIMM_F1 failed test/initialization	Major
8530	DIMM_F2 failed test/initialization	Major
3531	DIMM F3 failed test/initialization	Major
3532	DIMM_G1 failed test/initialization	Major
3533	DIMM G2 failed test/initialization	Major
3534	DIMM_G3 failed test/initialization	Major
8535	DIMM_H1 failed test/initialization	Major
3536	DIMM H2 failed test/initialization	Major
3530 8537	DIMM_H3 failed test/initialization	Major
8538	DIMM_10 failed test/initialization	Major
8539	DIMM_12 failed test/initialization	Major
853A	DIMM_13 failed test/initialization	Major
	DIMM_13 failed test/initialization	Major
853B		

Error Code	Error Message	Response
853D	DIMM J3 failed test/initialization	Major
853E	DIMM_K1 failed test/initialization	Major
853F	DIMM_K2 failed test/initialization	Major
(Go to		,
85C0)		
8540	DIMM_A1 disabled	Major
8541	DIMM_A2 disabled	Major
8542	DIMM_A3 disabled	Major
8543	DIMM_B1 disabled	Major
8544	DIMM_B2 disabled	Major
8545	DIMM_B3 disabled	Major
8546 8547	DIMM_C1 disabled	Major
8548	DIMM_C2 disabled DIMM_C3 disabled	Major Major
8549	DIMM_C3 disabled	Major
854A	DIMM_D1 disabled	Major
854B	DIMM_D3 disabled	Major
854C	DIMM_E0 disabled	Major
854D	DIMM_E2 disabled	Major
854E	DIMM_E3 disabled	Major
854F	DIMM_F1 disabled	Major
8550	DIMM_F2 disabled	Major
8551	DIMM_F3 disabled	Major
8552	DIMM_G1 disabled	Major
8553	DIMM_G2 disabled	Major
8554	DIMM_G3 disabled	Major
8555	DIMM_H1 disabled	Major
8556	DIMM_H2 disabled	Major
8557	DIMM_H3 disabled	Major
8558	DIMM_I1 disabled	Major
8559	DIMM_12 disabled	Major
855A 855B	DIMM_I3 disabled	Major
855C	DIMM_J1 disabled DIMM_J2 disabled	Major
855D	DIMM_J2 disabled	Major Major
855E	DIMM_J3 disabled	Major
855F	DIMM_K1 disabled	Major
(Go to		Major
85D0)		
8560	DIMM_A1 encountered a Serial Presence Detection (SPD) failure	Major
8561	DIMM_A2 encountered a Serial Presence Detection (SPD) failure	Major
8562	DIMM_A3 encountered a Serial Presence Detection (SPD) failure	Major
8563	DIMM_B1 encountered a Serial Presence Detection (SPD) failure	Major
8564	DIMM_B2 encountered a Serial Presence Detection (SPD) failure	Major
8565	DIMM_B3 encountered a Serial Presence Detection (SPD) failure	Major
8566	DIMM_C1 encountered a Serial Presence Detection (SPD) failure	Major
8567	DIMM_C2 encountered a Serial Presence Detection (SPD) failure	Major
8568	DIMM_C3 encountered a Serial Presence Detection (SPD) failure	Major
8569	DIMM_D1 encountered a Serial Presence Detection (SPD) failure	Major
856A	DIMM_D2 encountered a Serial Presence Detection (SPD) failure	Major
856B	DIMM_D3 encountered a Serial Presence Detection (SPD) failure	Major
856C 856D	DIMM_E1 encountered a Serial Presence Detection (SPD) failure	Major Major
856E	DIMM_E2 encountered a Serial Presence Detection (SPD) failure DIMM_E3 encountered a Serial Presence Detection (SPD) failure	Major
856F	DIMM_ES encountered a Serial Presence Detection (SPD) failure	Major
8570	DIMM_F2 encountered a Serial Presence Detection (SPD) failure	Major
8571	DIMM_r2 encountered a Serial Presence Detection (SPD) failure	Major
8572	DIMM_G1 encountered a Serial Presence Detection (SPD) failure	Major
		Major
8573	DIVIVI GZ ENCOUNTEIEU a SENAI FIESENCE DELECTION (SFD) MITURE	
8573 8574	DIMM_G2 encountered a Serial Presence Detection (SPD) failure DIMM_G3 encountered a Serial Presence Detection (SPD) failure	Major

Error Code	Error Message	Response
8576	DIMM_H2 encountered a Serial Presence Detection (SPD) failure	Major
8577	DIMM_H3 encountered a Serial Presence Detection (SPD) failure	Major
8578	DIMM_I1 encountered a Serial Presence Detection (SPD) failure	Major
8579	DIMM_I2 encountered a Serial Presence Detection (SPD) failure	Major
857A	DIMM_I3 encountered a Serial Presence Detection (SPD) failure	Major
857B	DIMM_J1 encountered a Serial Presence Detection (SPD) failure	Major
857C	DIMM_J2 encountered a Serial Presence Detection (SPD) failure	Major
857D	DIMM_J3 encountered a Serial Presence Detection (SPD) failure	Major
857E	DIMM_K1 encountered a Serial Presence Detection (SPD) failure	Major
857F	DIMM_K2 encountered a Serial Presence Detection (SPD) failure	Major
(Go to		
85E0)		
85C0	DIMM_K3 failed test/initialization	Major
85C1	DIMM_L1 failed test/initialization	Major
85C2	DIMM_L2 failed test/initialization	Major
85C3	DIMM_L3 failed test/initialization	Major
85C4	DIMM_M1 failed test/initialization	Major
85C5	DIMM_M2 failed test/initialization	Major
85C6	DIMM_M3 failed test/initialization	Major
85C7	DIMM_N1 failed test/initialization	Major
85C8	DIMM_N2 failed test/initialization	Major
85C9	DIMM_N3 failed test/initialization	Major
85CA	DIMM_01 failed test/initialization	Major
85CB	DIMM_O2 failed test/initialization	Major
85CC	DIMM_O3 failed test/initialization	Major
85CD	DIMM_P1 failed test/initialization	Major
85CE	DIMM_P2 failed test/initialization	Major
85CF	DIMM_P3 failed test/initialization	Major
85D0	DIMM_K3 disabled	Major
85D1	DIMM_L1 disabled	Major
85D2	DIMM_L2 disabled	Major
85D3	DIMM_L3 disabled	Major
85D4	DIMM_M1 disabled	Major
85D5	DIMM_M2 disabled	Major
85D6	DIMM_M3 disabled	Major
85D7	DIMM_N1 disabled	Major
85D8	DIMM_N2 disabled	Major
85D9	DIMM_N3 disabled	Major
85DA	DIMM_O1 disabled	Major
85DB	DIMM_O2 disabled	Major
85DC	DIMM_O3 disabled	Major
85DD	DIMM_P1 disabled	Major
85DE	DIMM_P2 disabled	Major
85DF	DIMM_P3 disabled	Major
85E0	DIMM_K3 encountered a Serial Presence Detection (SPD) failure	Major
85E1	DIMM_L1 encountered a Serial Presence Detection (SPD) failure	Major
85E2	DIMM_L2 encountered a Serial Presence Detection (SPD) failure	Major
85E3	DIMM_L3 encountered a Serial Presence Detection (SPD) failure	Major
85E4	DIMM_M1 encountered a Serial Presence Detection (SPD) failure	Major
85E5	DIMM_M2 encountered a Serial Presence Detection (SPD) failure	Major
85E6	DIMM_M3 encountered a Serial Presence Detection (SPD) failure	Major
85E7	DIMM_N1 encountered a Serial Presence Detection (SPD) failure	Major
85E8	DIMM_N2 encountered a Serial Presence Detection (SPD) failure	Major
85E9	DIMM_N3 encountered a Serial Presence Detection (SPD) failure	Major
85EA	DIMM_O1 encountered a Serial Presence Detection (SPD) failure	Major
85EB	DIMM_O2 encountered a Serial Presence Detection (SPD) failure	Major
85EC	DIMM_O3 encountered a Serial Presence Detection (SPD) failure	Major
85ED	DIMM_P1 encountered a Serial Presence Detection (SPD) failure	Major
85EE	DIMM_P2 encountered a Serial Presence Detection (SPD) failure	Major
85EF	DIMM_P3 encountered a Serial Presence Detection (SPD) failure	Major
8604	POST Reclaim of non-critical NVRAM variables	Minor

Error Code	Error Message	Response
8605	BIOS Settings are corrupted	Major
8606	NVRAM variable space was corrupted and has been reinitialized	Major
92A3	Serial port component was not detected	Major
92A9	Serial port component encountered a resource conflict error	Major
A000	TPM device not detected.	Minor
A001	TPM device missing or not responding.	Minor
A002	TPM device failure.	Minor
A003	TPM device failed self test.	Minor
A100	BIOS ACM Error	Major
A421	PCI component encountered a SERR error	Fatal
A5A0	PCI Express* component encountered a PERR error	Minor
A5A1	PCI Express* component encountered an SERR error	Fatal
A6A0	DXE Boot Service driver: Not enough memory available to shadow a Legacy Option ROM	Minor

POST Error Beep Codes

The following table lists the POST error beep codes. Prior to system video initialization, the BIOS uses these beep codes to inform users on error conditions. The beep code is followed by a user-visible code on the POST Progress LEDs.

Beeps	Error Message	POST Progress Code	Description
1	USB device action	NA	Short beep sounded whenever a USB device is discovered in POST, or inserted or removed during runtime
1 long	Intel [®] TXT security violation	0xAE, 0xAF	System halted because Intel [®] Trusted Execution Technology detected a potential violation of system security.
3	Memory error	See Tables 28 and 29	System halted because a fatal error related to the memory was detected.
2	BIOS Recovery started	NA	Recovery boot has been initiated
4	BIOS Recovery failure	NA	BIOS recovery has failed. This typically happens so quickly after recovery us initiated that it sounds like a 2-4 beep code.

Table 29. POST Error Beep Codes

The Integrated BMC may generate beep codes upon detection of failure conditions. Beep codes are sounded each time the problem is discovered, such as on each power-up attempt, but are not sounded continuously. Codes that are common across all Intel[®] server boards and systems that use same generation chipset are listed in the following table. Each digit in the code is represented by a sequence of beeps whose count is equal to the digit.

Table 30. Integrated BMC Beep Codes

Code	Reason for Beep	Associated Sensors
1-5-2-1	No CPUs installed or first CPU socket is empty.	 CPU1 socket is empty, or sockets are populated incorrectly CPU1 must be populated before CPU2.
1-5-2-4	MSID Mismatch	MSID mismatch occurs if a processor is installed into a system board that has incompatible power capabilities.

Intel[®] Server System R1000EP Product Family TPS

Code	Reason for Beep	Associated Sensors
1-5-4-2	Power fault	DC power unexpectedly lost (power good dropout) – Power unit sensors report power unit failure offset
1-5-4-4	Power control fault (power good assertion timeout).	Power good assertion timeout – Power unit sensors report soft power control failure offset
1-5-1-2	VR Watchdog Timer sensor assertion	VR controller DC power on sequence was not completed in time.
1-5-1-4	Power Supply Status	The system does not power on or unexpectedly powers off and a Power Supply Unit (PSU) is present that is an incompatible model with one or more other PSUs in the system.

Glossary

Word/Acronym	Definition
ACA	Australian Communication Authority
ANSI	American National Standards Institute
BMC	Baseboard Management Controller
BIOS	Basic Input/Output System
CMOS	Complementary Metal-oxide-semiconductor
D2D	DC-to-DC
EMP	Emergency Management Port
FP	Front Panel
FRB	Fault Resilient Boot
FRU	Field Replaceable Unit
l ² C	Inter-integrated Circuit bus
LCD	Liquid Crystal Display
LPC	Low-pin Count
LSB	Least Significant Bit
MSB	Most Significant Bit
MTBF	Mean Time Between Failure
MTTR	Mean Time to Repair
NIC	Network Interface Card
NMI	Non-maskable Interrupt
OTP	Over-temperature Protection
OVP	Over-voltage Protection
PCI	Peripheral Component Interconnect
PCB	Printed Circuit Board
PCIe*	Peripheral Component Interconnect Express*
PCI-X	Peripheral Component Interconnect Extended
PFC	Power Factor Correction
POST	Power-on Self Test
PSU	Power Supply Unit
RAM	Random Access Memory
RI	Ring Indicate
SCA	Single Connector Attachment
SDR	Sensor Data Record
SE	Single-Ended
THD	Total Harmonic Distortion
UART	Universal Asynchronous Receiver Transmitter
USB	Universal Serial Bus
VCCI	Voluntary Control Council for Interference
VSB	Voltage Standby

Reference Documents

See the following documents for additional information:

- Intel[®] Server Board S2400EP Technical Product Specification
- Intel[®] Server Board S2400EP Product Family Spares/Parts List and Configuration Guide
- Intel[®] Server System R1000EP Service Guide
- Intel[®] Server System R1000EP Quick Installation Guide
- BIOS for EPSD Platforms Based on Intel[®] Xeon Processor E5-4600/2600/2400/1600 Product Families External Product Specification
- EPSD Platforms Based On Intel[®] Xeon[®] Processor E5 4600/2600/2400/1600 Product Families BMC Core Firmware External Product Specification
- Intel[®] Integrated RAID Module RMS25PB080, RMS25PB040, RMS25CB080, and RMS25CB040 Hardware Users Guide
- Intel[®] Remote Management Module 4 Technical Product Specification
- Intel[®] Remote Management Module 4 and Integrated BMC Web Console Users Guide